110 W / 54 V Power Supply Demo Board using ICL5101 in PFC & LLC Topology

Application Note

About this document

Scope and purpose

This document presents the details about the ICL5101 evaluation board and ICL5101 product feature set. It illustrates all necessary steps to get the board and related environment up and running, and provides all information to become familiar with this comprehensive solution. The evaluation board passes EMI conductive, radiated and is CE certificated.

The ICL5101 is a mixed signal PFC + resonant controller for non-dimmable and dimmable LED light applications using LLC topology for highest efficiency levels exceeding 94 %, including a PFC stage for lowest THD < 5 % and high power factor correction figures > 95 % @ > 50 % load in a wide line input voltage range. The ICL5101 evaluation board is designed to evaluate the performance and flexibility of the ICL5101. It supports an output power of 110 W, easily configurable by using only resistor settings without any user interface tool.

Intended audience

This document is intended for anyone who needs to use the ICL5101 evaluation board, either for their own application tests or to use it as a reference for a new ICL5101-based development.

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1 Introduction

This application note describes the characteristics and features of a 110 W SMPS demonstration board with constant 54 V voltage output. High efficiency, high PF, low THD and very stable output voltage with low ripple at whole power range are the key features of this demonstration board, which makes it very suitable to be used as a primary power supply for low power systems, such as LED lighting. Its compact design and low BOM cost is due to Infineon IC ICL5101 (CrCM PFC and resonant block are integrated together), which is used as main controller here. With this highly integrated smart IC, the circuit design is dramatically simplified, which results space and BOM cost saving. Furthermore, numerous monitor and protection features ensure highest reliability.

Key specification measurements and waveforms are also shown in this application note.

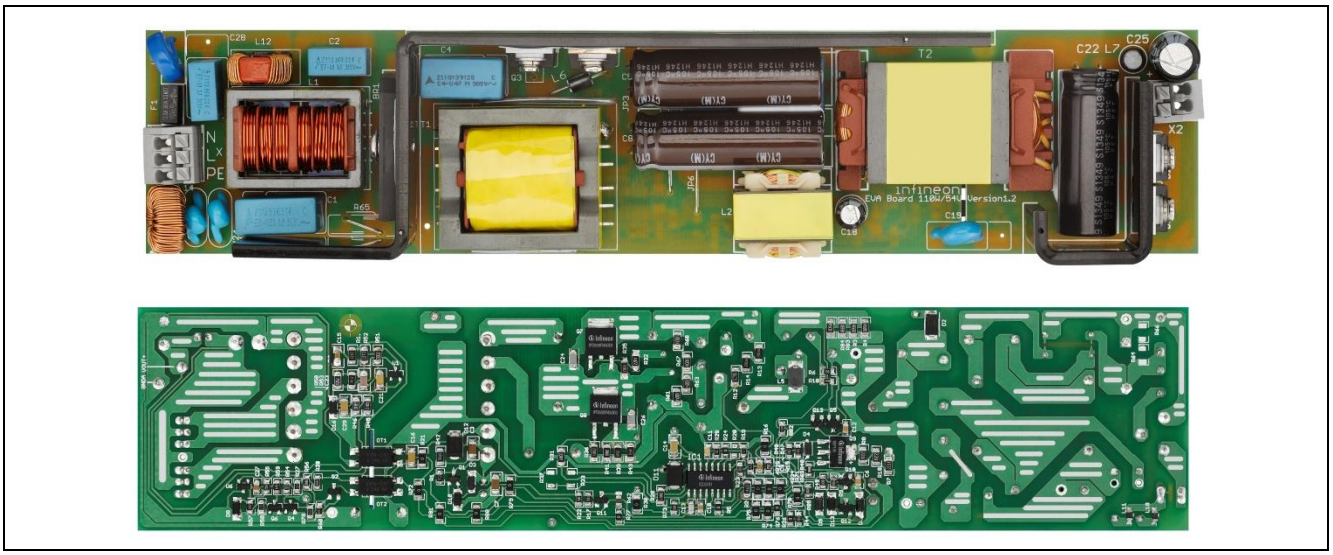


Figure 1 Demonstration Board of 110 W / 54 V LED Driver

2 Technical Specification

This demo board consists of a CrCM PFC and a half-bridge LLC, which outputs a stable 54 V_{DC} voltage.

The PFC stage of this demo board is controlled by the PFC block of the ICL5101, which has an integrated digital PFC control loop and improved compensation for low THD of AC input current. It operates in critical conduction mode (CrCM) in a load range from 10 % to 100 % to achieve a very good power factor and very low THD. When the load is smaller than 10 %, in order to limit the PFC switching frequency, the IC controls the PFC to operate in discontinuous conduction mode (DCM).

The half-bridge LLC stage has a fixed duty cycle of D=0.5 and an adjustable self-adapting dead time from 0.5 µs to 1 µs. The operation frequency starts from typical 135 kHz at start-up and decreases to a range of between 45 kHz (full load) and 75 kHz (output open loop). The 54 V output voltage has a very stable value throughout the whole output power range. The value variation is tested to be smaller than 0.2 % from full load to open loop. Over voltage protection (OVP) is implemented at the main output. When the output voltage reaches 60 V, the main converter is stopped by the OVP circuit. It starts to operate again when the main output decreases to 54 V. In addition, many other protection functions are also implemented, such as Output Short Circuit Protection of the main output (OSCP), LLC primary winding short circuit protection (WSCP), Capacitive Mode Protection of the main output (CMP), LLC Over Current Protection (LOCP), over temperature protection (OTP) at certain hot spot on board and more. These protection functions are realized by the built-in protection functions of the IC ICL5101.

Features

- Input voltage range: 85–305 V_{AC}
- Input voltage frequency: 47–63 Hz
- Regulated main output voltage: 54 V_{DC} / 2.06 A
- Efficiency at nominal load: ≥ 93.5 % at 230 V_{AC}
- Input current THD: < 10 % @ > 35% Load at 230 V_{AC}
- Harmonics: According to EN61000-3-2 Class-D
- EMI: According to EN55015
- Safety : According to EN61347-2-13
- Board dimensions: 247.3 mm (L) x 48.25 mm (W) x 34.2 mm (H)

3 Schematic

Figure 2 shows the schematic of the ICL5101 demonstration board.

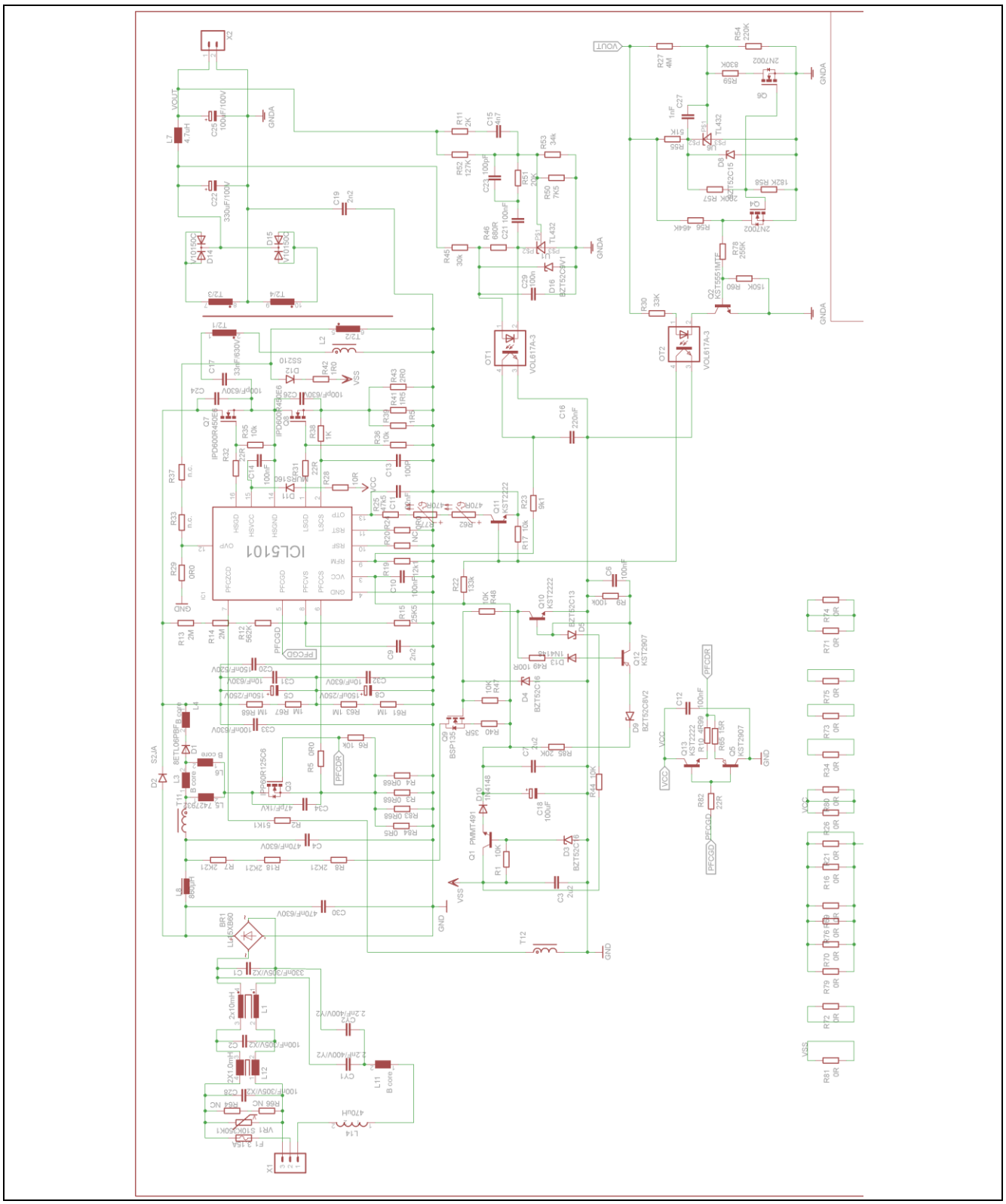


Figure 2 Schematic of 110 W / 54 V Power Supply Demo Board

4 Key Measurements and Waveforms

4.1 Line Regulation, Startup Time, Load Regulation, PF and THD

4.1.1 Line Regulation

The output voltage of the demo board is tested under nominal load (110 W) with input voltages from 85 VAC up to 300 VAC.

The detailed test results are shown in **Figure 3**.

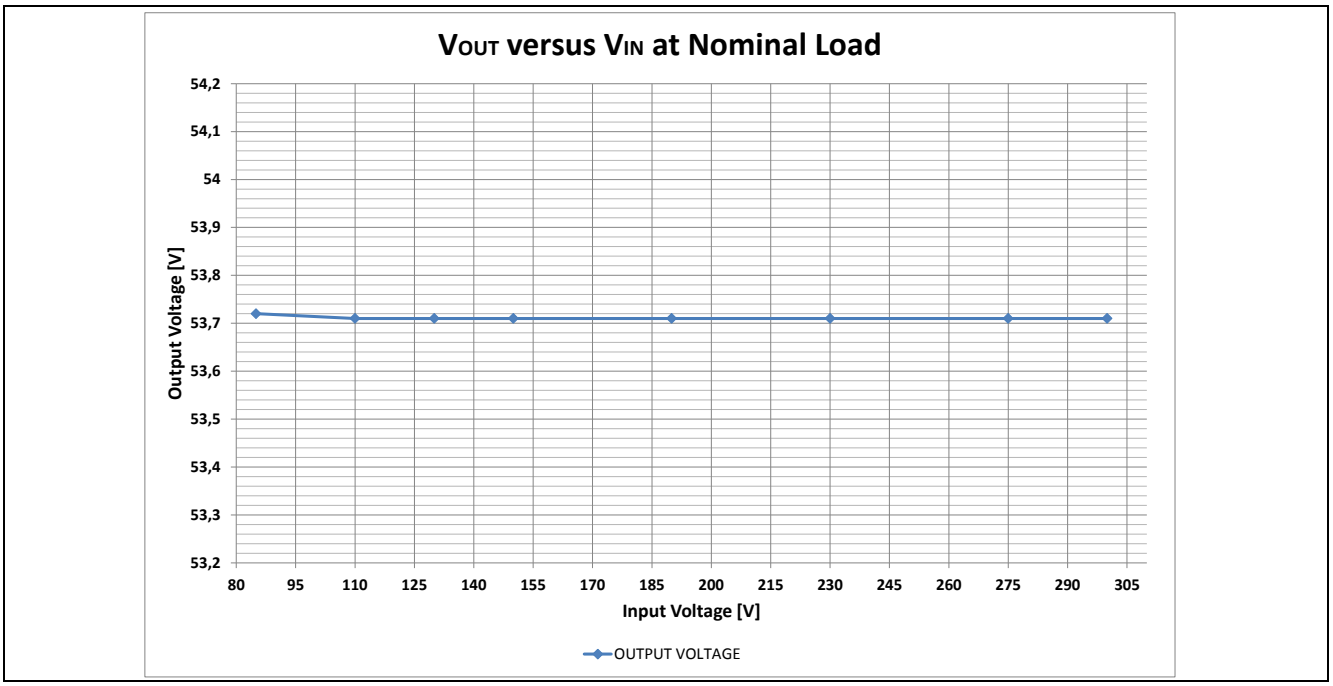


Figure 3 DC Output Voltage at Different V_{IN} Values

4.1.2 Startup Time

Start-up time is shorter than 200ms at whole input voltage and power range. Oscilloscope pictures are shown in pictures from **Figure 4** to **Figure 9**

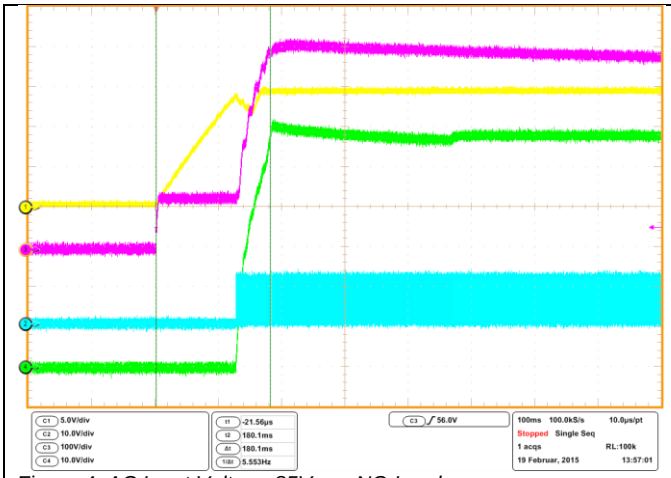


Figure 4: *AC Input Voltage 85V_{ACIN}, NO Load*

CH1: Chip Supply Voltage V_{CC} (Yellow) to IC GND; 5V/div
CH2: Low Side Gate Drive V_{LSGD} (Blue) to IC GND; 10V/div
CH3: PFC BUS Voltage V_{BUS} to Power GND (Magenta); 100V/div
CH4: Output Voltage V_{OUT} (Green) to Sec GND; 10V/div
Time: 100ms/div;
Start-up time:180.1ms

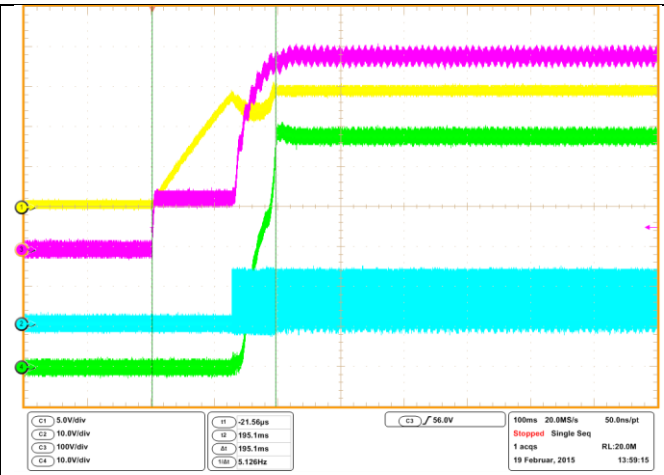


Figure 5: *AC Input Voltage 85V_{ACIN}, Full Load*

CH1: Chip Supply Voltage V_{CC} (Yellow) to IC GND; 5V/div
CH2: Low Side Gate Drive V_{LSGD} (Blue) to IC GND; 10V/div
CH3: PFC BUS Voltage V_{BUS} to Power GND (Magenta); 100V/div
CH4: Output Voltage V_{OUT} (Green) to Sec GND; 10V/div
Time: 100ms/div;
Start-up time:195.1ms

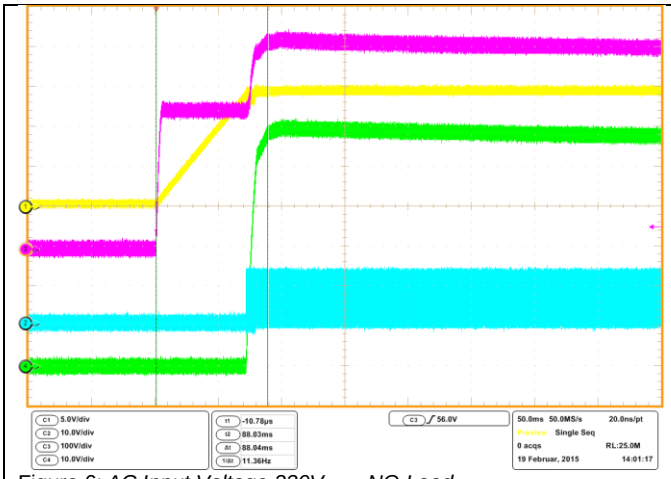


Figure 6: *AC Input Voltage 230V_{ACIN}, NO Load*

CH1: Chip Supply Voltage V_{CC} (Yellow) to IC GND; 5V/div
CH2: Low Side Gate Drive V_{LSGD} (Blue) to IC GND; 10V/div
CH3: PFC BUS Voltage V_{BUS} to Power GND (Magenta); 100V/div
CH4: Output Voltage V_{OUT} (Green) to Sec GND; 10V/div
Time: 50ms/div;
Start-up time: 88ms

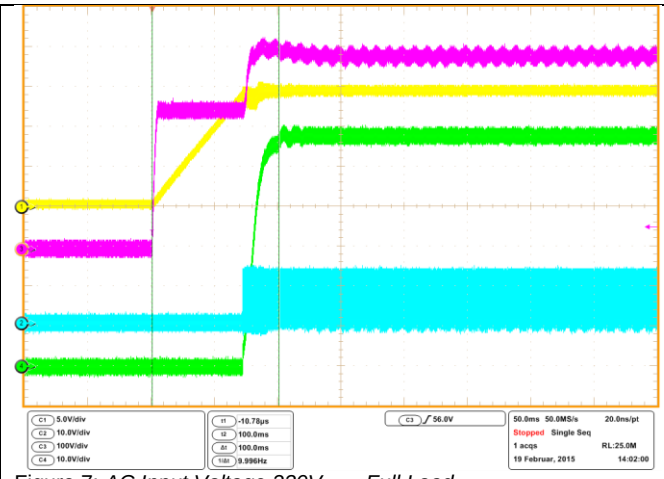


Figure 7: *AC Input Voltage 230V_{ACIN}, Full Load*

CH1: Chip Supply Voltage V_{CC} (Yellow) to IC GND; 5V/div
CH2: Low Side Gate Drive V_{LSGD} (Blue) to IC GND; 10V/div
CH3: PFC BUS Voltage V_{BUS} to Power GND (Magenta); 100V/div
CH4: Output Voltage V_{OUT} (Green) to Sec GND; 10V/div
Time: 50ms/div;
Start-up time: 100ms

Key Measurements and Waveforms

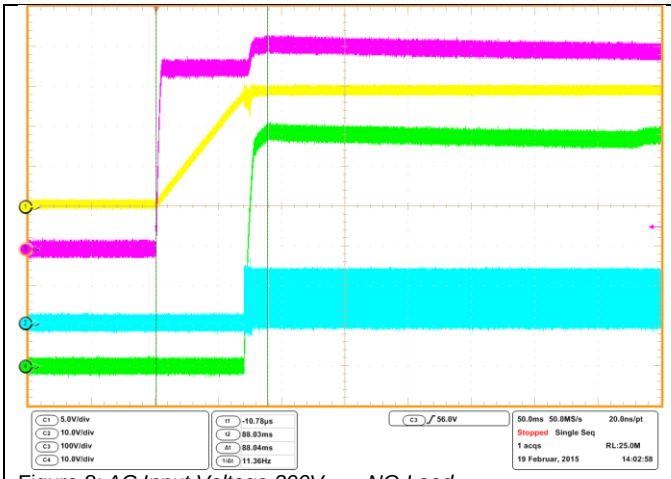


Figure 8: *AC Input Voltage 300V_{ACIN}, NO Load*

CH1: Chip Supply Voltage V_{CC} (Yellow) to IC GND; 5V/div
CH2: Low Side Gate Drive V_{LSGD} (Blue) to IC GND; 10V/div
CH3: PFC BUS Voltage V_{BUS} to Power GND (Magenta); 100V/div
CH4: Output Voltage V_{OUT} (Green) to Sec GND; 10V/div
Time: 50ms/div;
Start-up time: 88ms

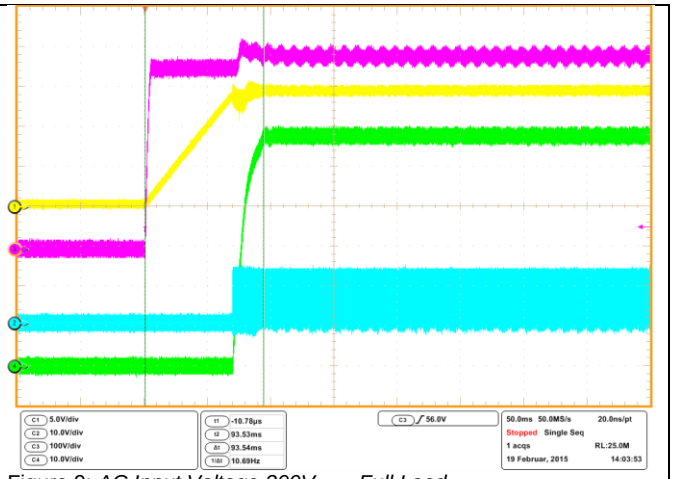


Figure 9: *AC Input Voltage 300V_{ACIN}, Full Load*

CH1: Chip Supply Voltage V_{CC} (Yellow) to IC GND; 5V/div
CH2: Low Side Gate Drive V_{LSGD} (Blue) to IC GND; 10V/div
CH3: PFC BUS Voltage V_{BUS} to Power GND (Magenta); 100V/div
CH4: Output Voltage V_{OUT} (Green) to Sec GND; 10V/div
Time: 50ms/div;
Start-up time: 93.5ms

4.1.3 Load Regulation

The output voltage of the demo board is tested at 230 VAC input voltage and with loads from 0 % up to 100 % (110 W). The detailed test results are shown in **Figure 10**.

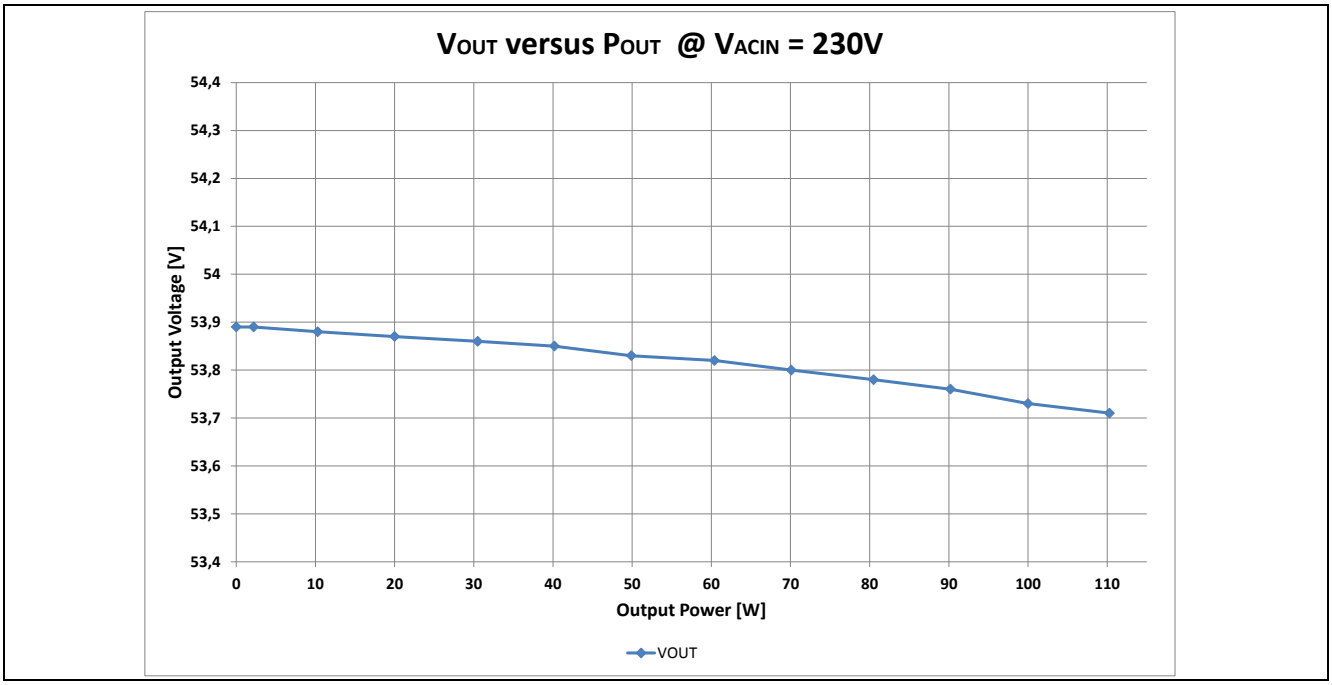


Figure 10 Output Voltage V_{OUT} versus P_{OUT}

4.1.4 PF and THD vs. POUT

Due to the smart internal digital PFC controller and improved THD correction of the ICL5101, PF values of greater than 94 % and THD values of lower than 10 % from loads upwards of 45 % are achieved at V_{IN} = 230 VAC. The detailed test results are shown in **Figure 11**.

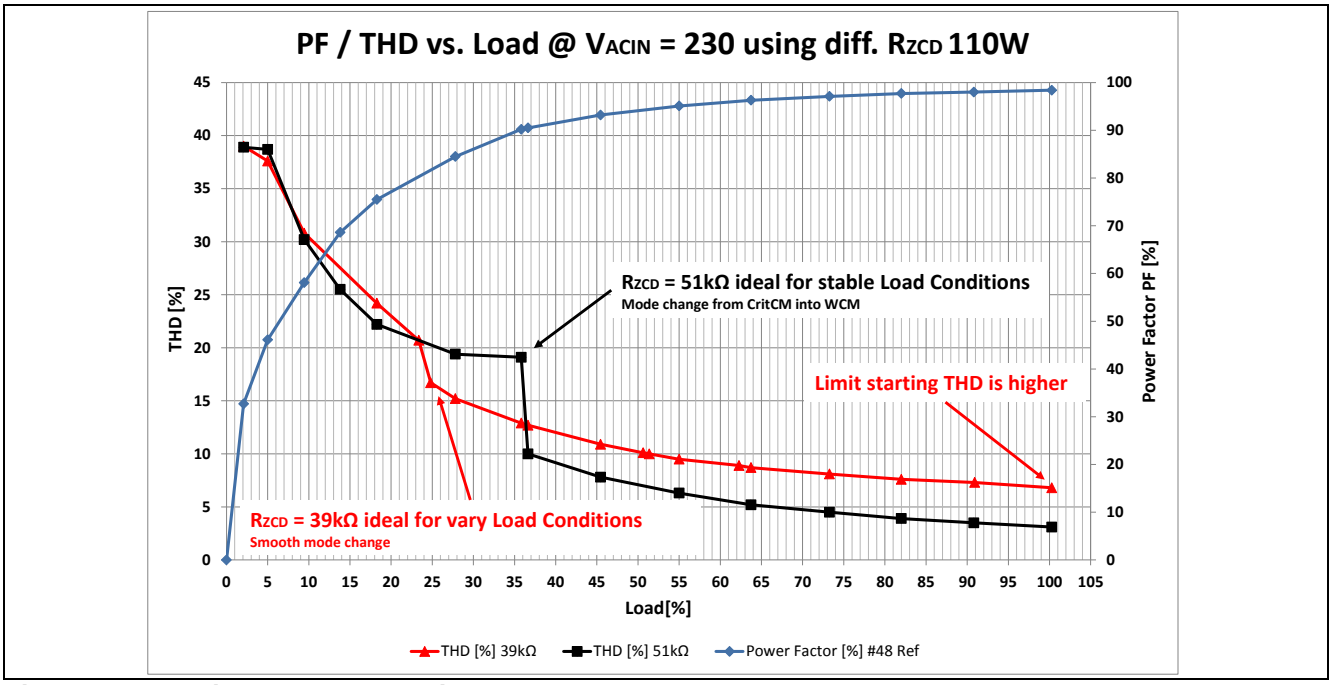


Figure 11 PF and THD versus Load

Key Measurements and Waveforms

Introduction THD Adjustment:

In order to provide an excellent THD result, the THD of the ICL5101 is adjustable. Especially at high line input voltage and low load condition, the THD is a critical value. It doesn´t matter in which condition:

- Line input voltage
- Stable load
- Load variation

the ICL5101 is providing best results for all cases – only in trimming the ZCD resistor at PIN 7 see Figure 12.

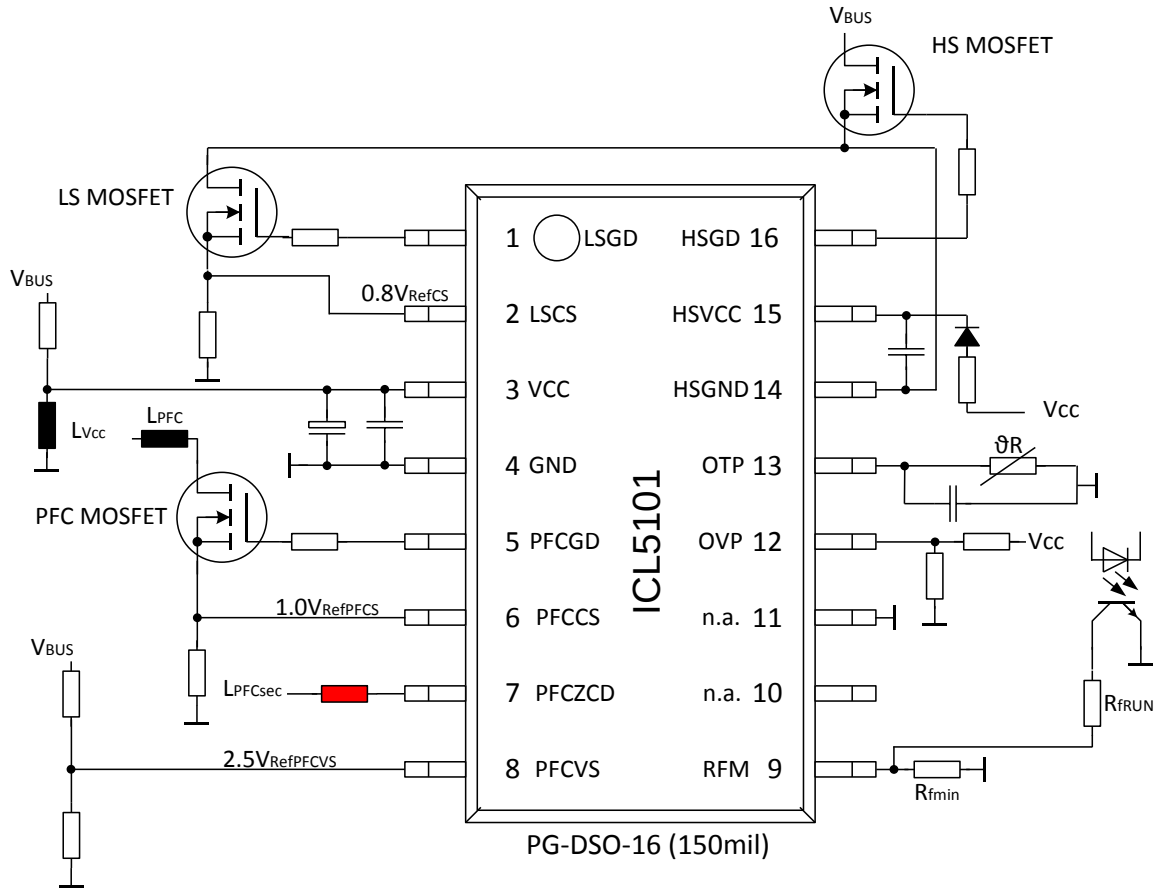


Figure 12 PIN SetUP ICL5101

How to do:

To improve the THD the resistor – see red signed resistor in Figure 12 – at ZCD PIN 7 can be trimmed to an optimal value (several k-ohm ~ 20 up to 100k) in order to reach best THD results.

Step one is to define the inductivity of the PFC choke and the MOSFET. After fixing PFC choke and transistor, two scenarios are happen:

1/ operation in **stable load** condition e.g. lamp ON / OFF

SET nominal load condition and vary the value of the resistor until you get the best THD results. Outcome sees in Figure 11 black curve

2/ operation with **load variation** e.g. dimming of an LED

Choose a resistor and vary the load. Change value up or down in order to get your best result over the whole load range – outcome sees Figure 11 red curve.

Key Measurements and Waveforms

Mechanism:
The controller operates in two modes:
- Critical Conduction Mode (CrCM) in a wide load range
- Wait Cycle Mode (WCM – a kind of DCM) for low load

Switch from CrCM into WCM):
The ICL5101 has an integrated logic which can be regulated via the resistor at the ZCD PIN 7 in varying the value of the resistor.

Limit:
The digital logic of the controller is limited. At high line input voltages, the controller reduces the ON time of the PFC gate driver. If the minimum ON time is reached – physically given by the internal digital stage – the controller switches over from the critical conduction mode CrCM into the wait cycle mode WCM. This switch over can be seen in the THD measurement shown in Figure xx. Depending on the load (stable or variable) the optimum configuration can be found, shown in . This effect can be prevented by trimming the resistor at the ZCD PIN 7 – lower the resistance leads to a smother cross over from CrCM into WCM (red curve) but increases slightly the THD.

4.2 Surge Protection

Description SURGE Protection

In case of a surge event, the voltage at the BUS capacitors C5 & C8 rises up, the driver stages of the ICL5101 are shut off when V_{LSCS} > 0.8V and V_{BUS} > 109% for longer than 500ns. After the surge the controller restarts automatically when V_{BUS} drops below 109% of the rated voltage. This feature allows driving 500V MOSFETs at the half bridge stage when adequate EMI and DC LINK networking is present.

SURGE Detection

If the bus voltage exceeds:

V_{BUS} > 109%

and the voltage at the low side current sense pin 2 exceeds:

V_{LSCS} > 0.8V

for longer than

t = 500ns

SURGE Protection

All Gate Drives OFF

Auto Restart:

V_{BUS} < 109%

Measurement

Surge Event of 1.7kV WITHOUT Varistor VR1

Figure 13: SURGE **1.7kV** / FULL Load / Detail
L → N / Phase: 90°
Ch 1 dark blue: V_{LSCS} LS Current Sense to IC GND
Ch 2 blue: V_{BUS} to Power GND
Ch 3 magenta: V_{LSDS} LS Drain to Power GND
Ch 4 green: V_{PFCDS} PFC Drain to Power GND

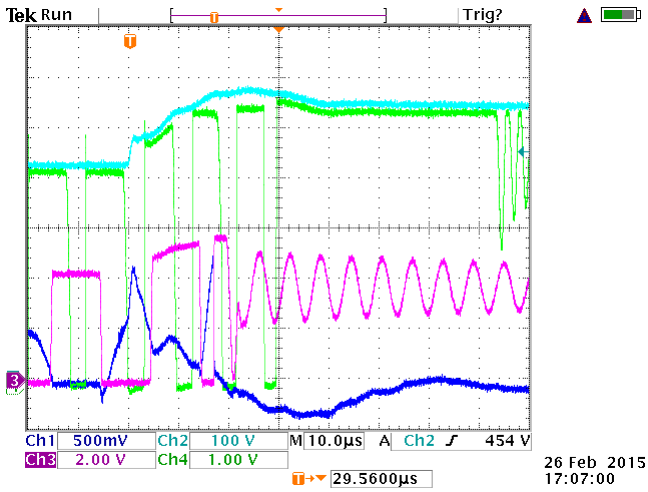
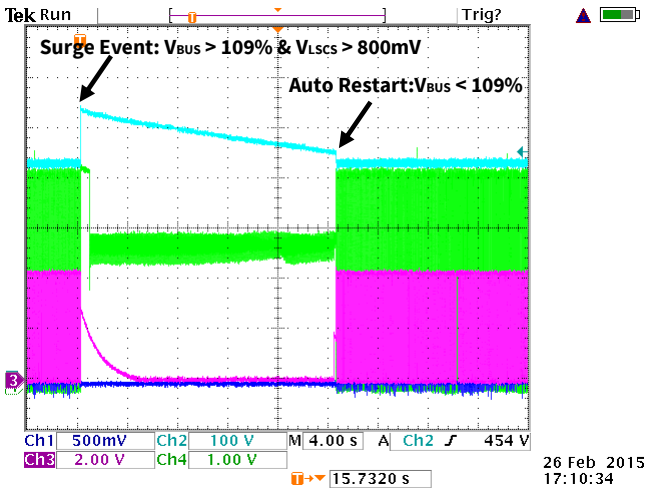


Figure 14: SURGE **1.7kV** / FULL Load / Auto Restart
L → N / Phase: 90°
Ch 1 dark blue: V_{LSCS} LS Current Sense to IC GND
Ch 2 blue: V_{BUS} to Power GND
Ch 3 magenta: V_{LSDS} LS Drain to Power GND
Ch 4 green: V_{PFCDS} PFC Drain to Power GND



4.3 Harmonics

Harmonics are tested according to the standard EN61000-3-2 Class-D, as shown in the following figures.

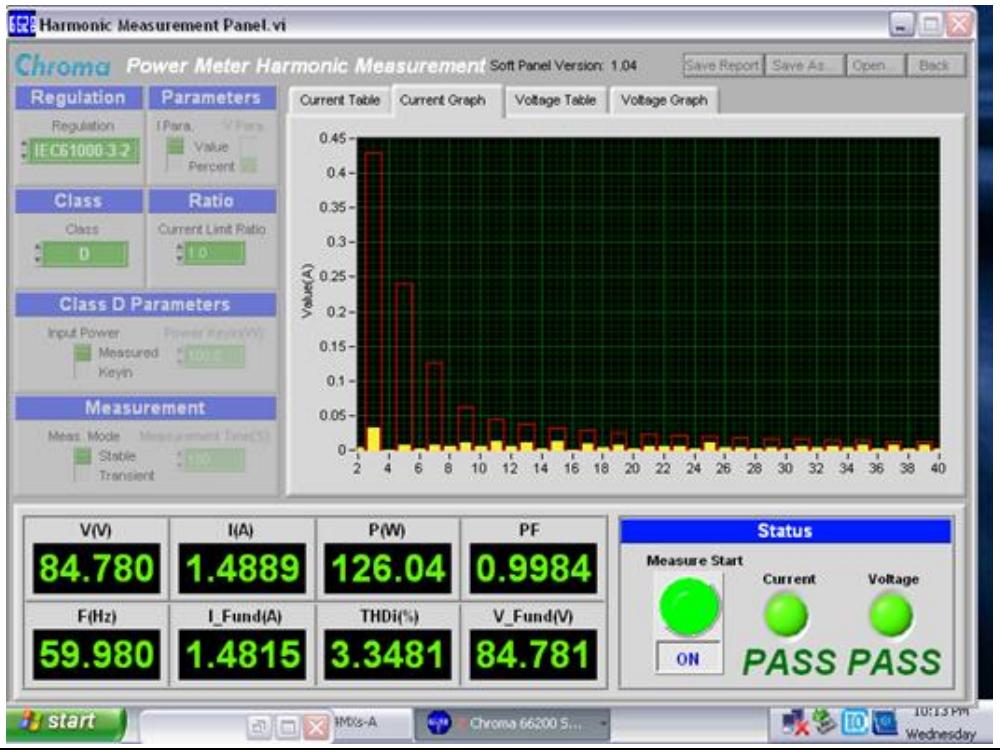


Figure 15 Input Current Harmonic Spectrum at Full Load and V_{IN} = 85 VAC

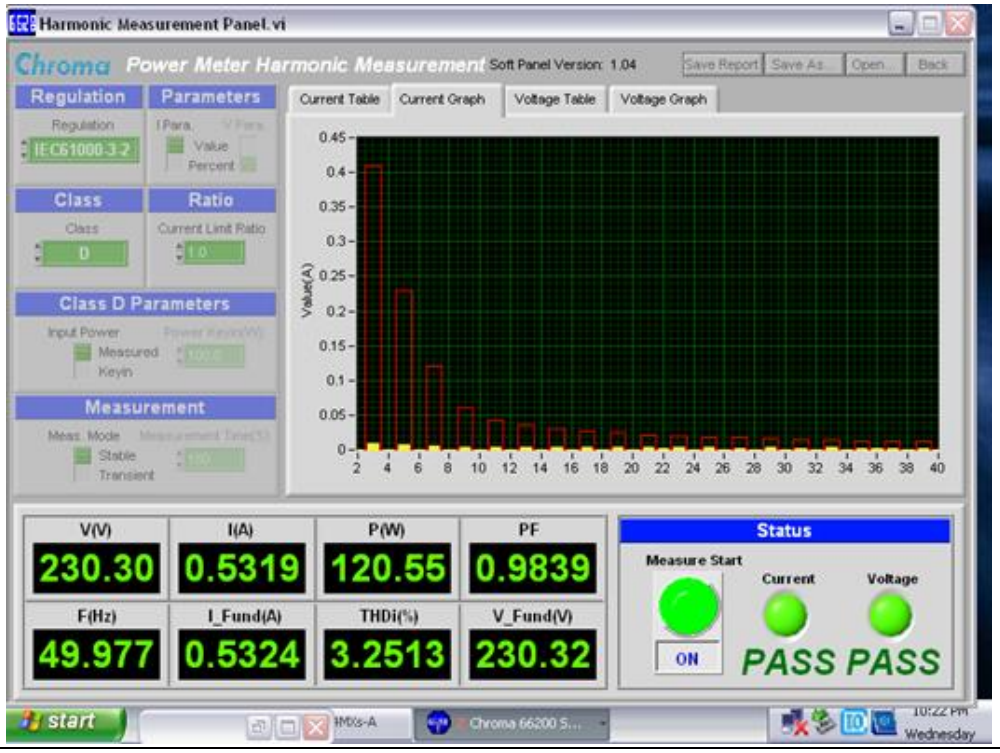


Figure 16 Input Current Harmonic Spectrum at Full Load and V_{IN} = 230 VAC

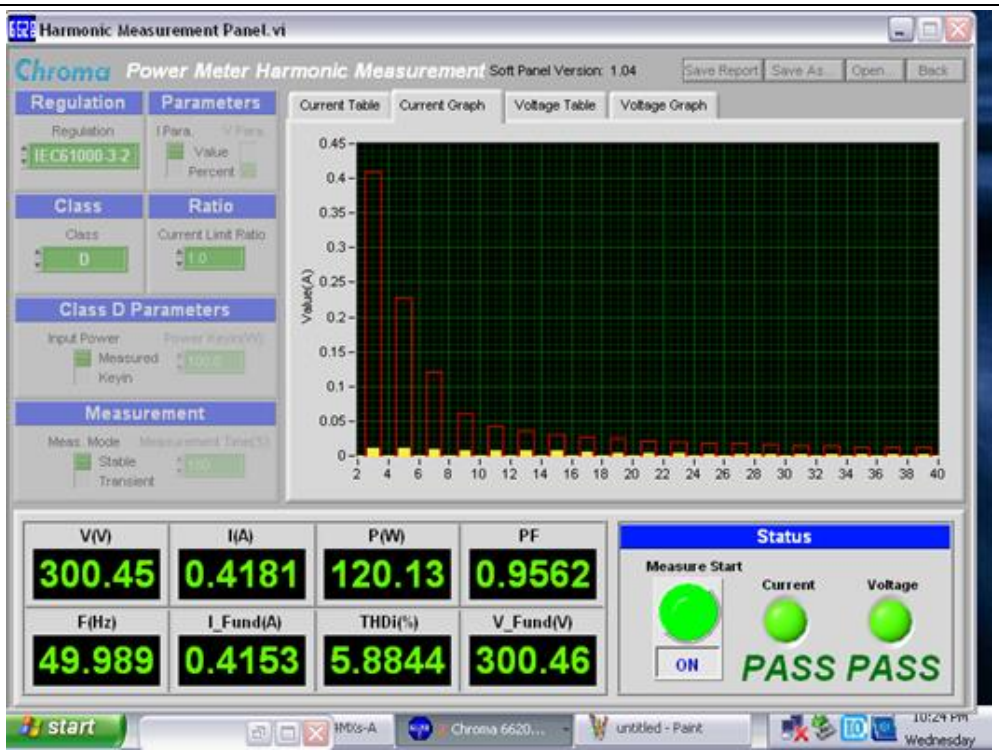


Figure 17 Input Current Harmonic Spectrum at Full Load and V_{IN} = 300 VAC

4.4 System Efficiency and Standby Power

4.4.1 System Efficiency

The efficiency of the demo board is tested at 230 VAC input voltage and under different output power from 0 W to 110 W.

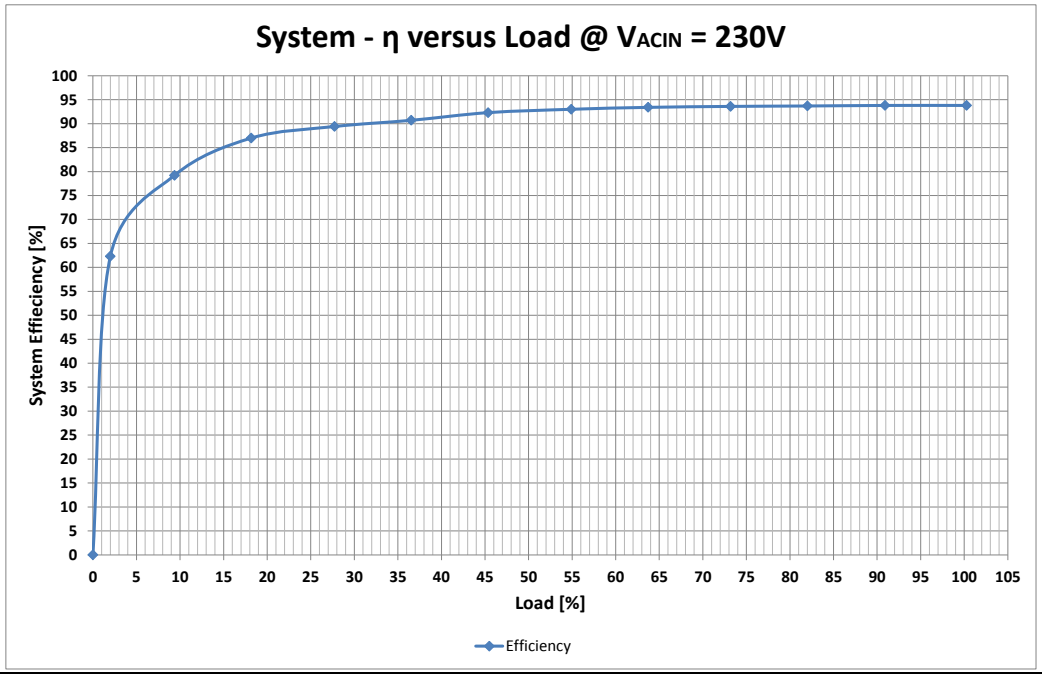


Figure 18 System Efficiency versus Load

4.4.2 Power Consumption at Output Open Loop (Standby Power)

At output open loop (NO Load), the power converter keeps the output voltage at a stable value of 54 V and will not go into burst mode.

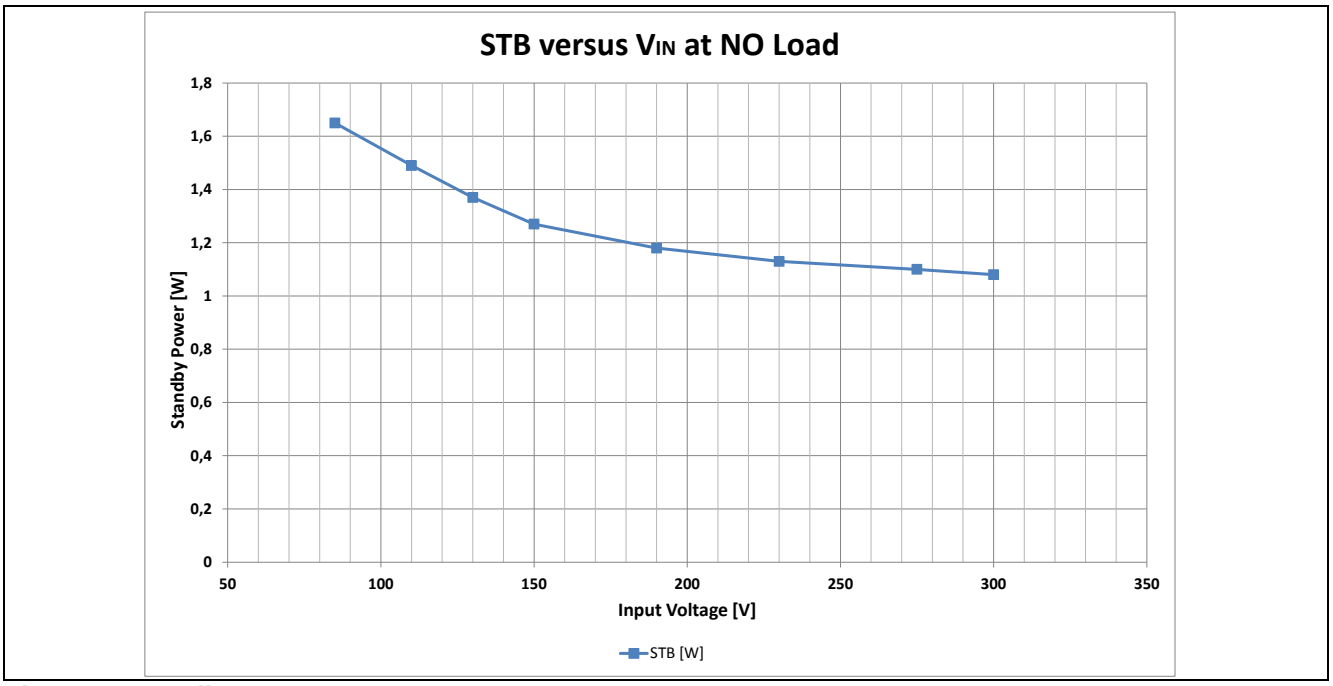


Figure 19 Standby Power versus V_{AC}

4.5 EMI Test

Conducted EMI and radiated EMI are tested according to the standard EN55015.

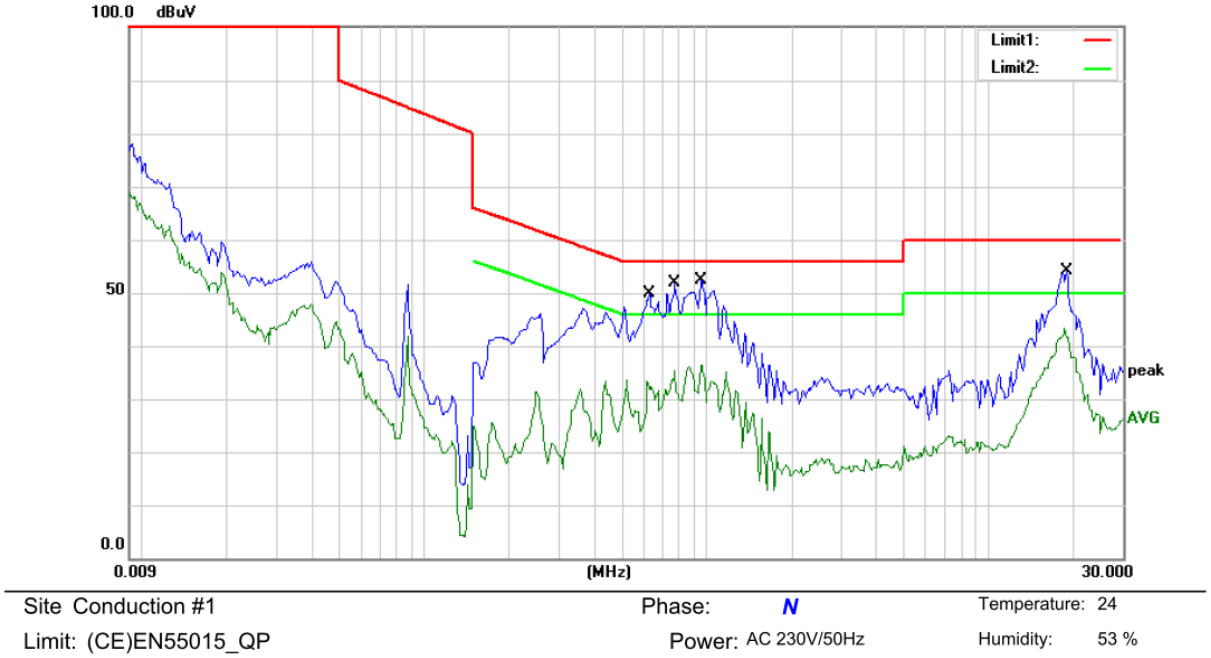


Figure 20 Conducted EMI -- 230VAC/50Hz N

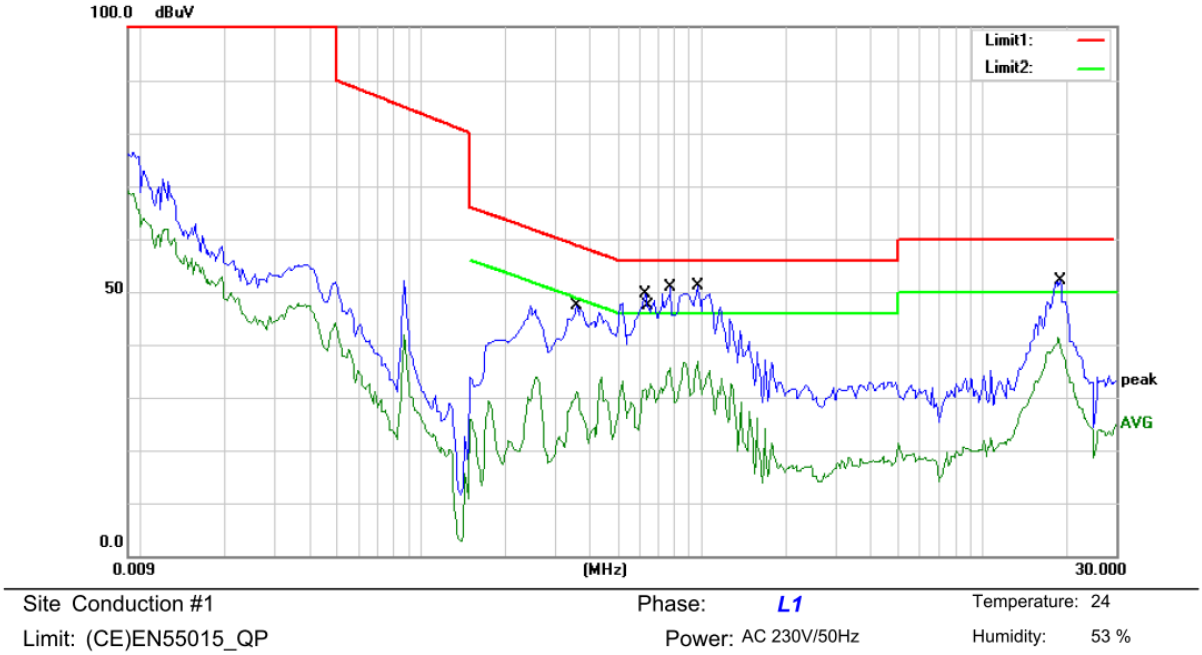


Figure 21 Conducted EMI -- 230VAC/50Hz L

Key Measurements and Waveforms

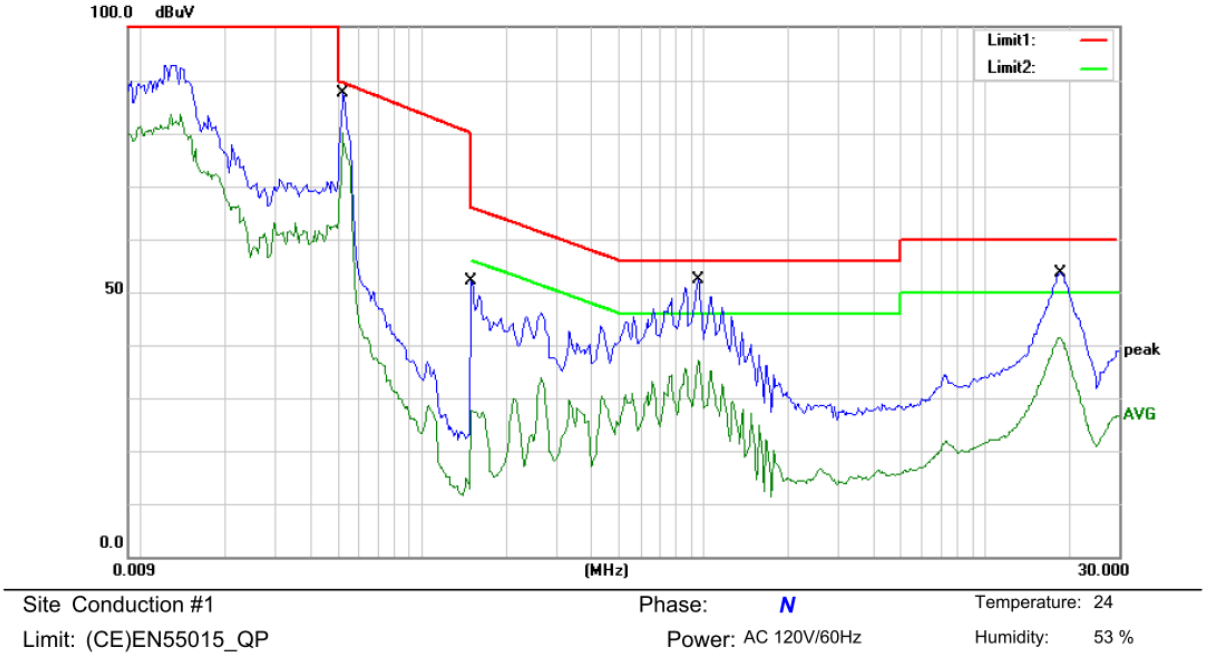


Figure 22 Conducted EMI -- 120VAC/60Hz N

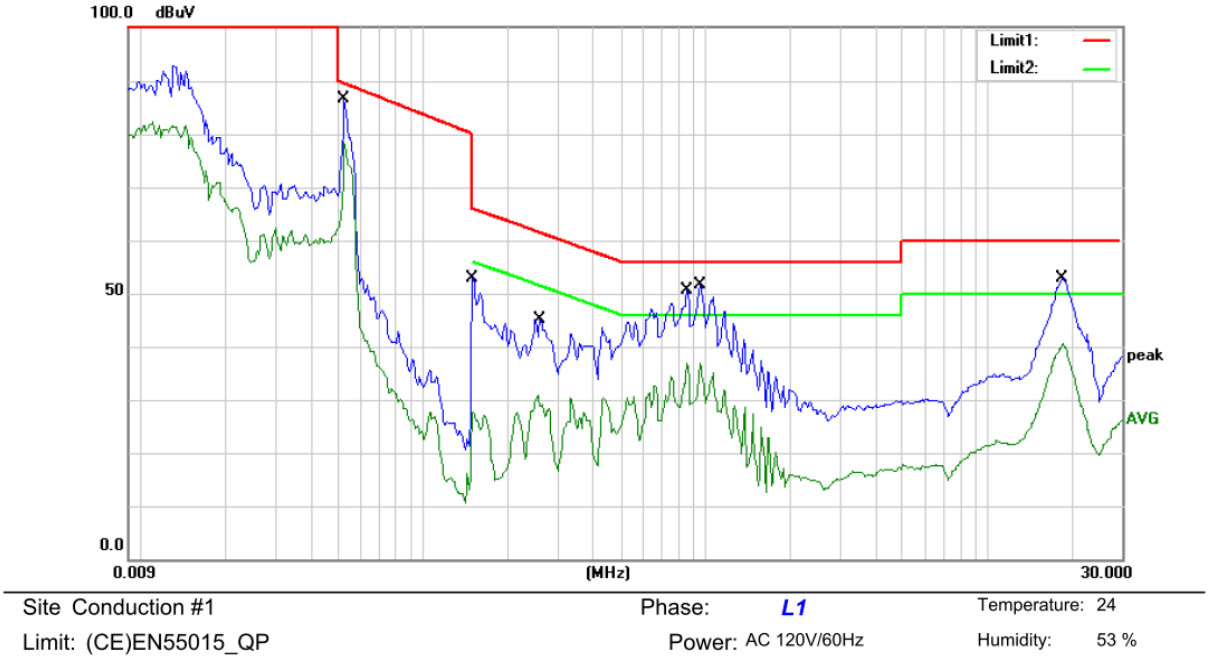


Figure 23 Conducted EMI -- 120VAC/60Hz L

Key Measurements and Waveforms

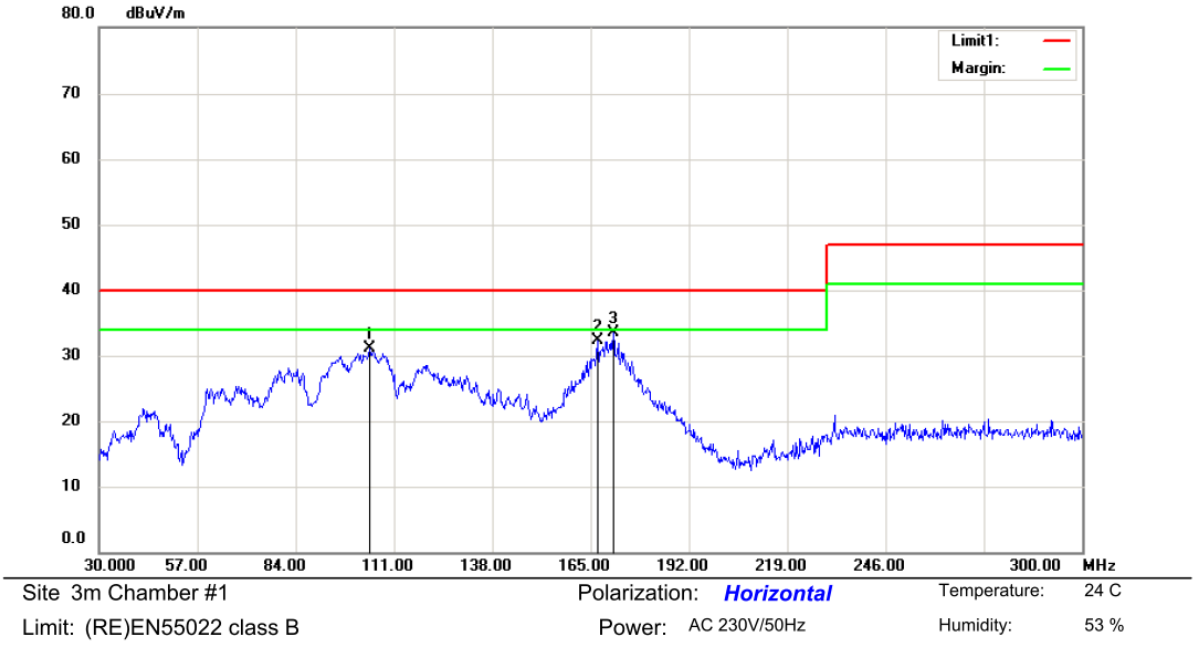


Figure 24 Radiated EMI -- 230VAC/50Hz Horizontal

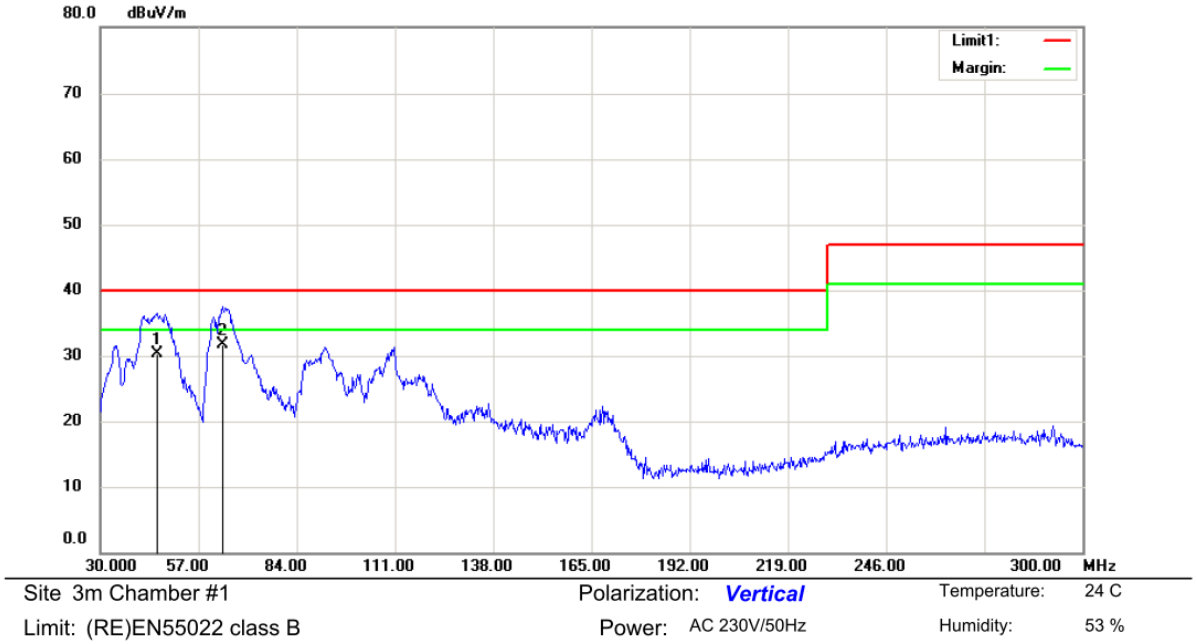


Figure 25 Radiated EMI -- 230VAC/50Hz Vertical

Key Measurements and Waveforms

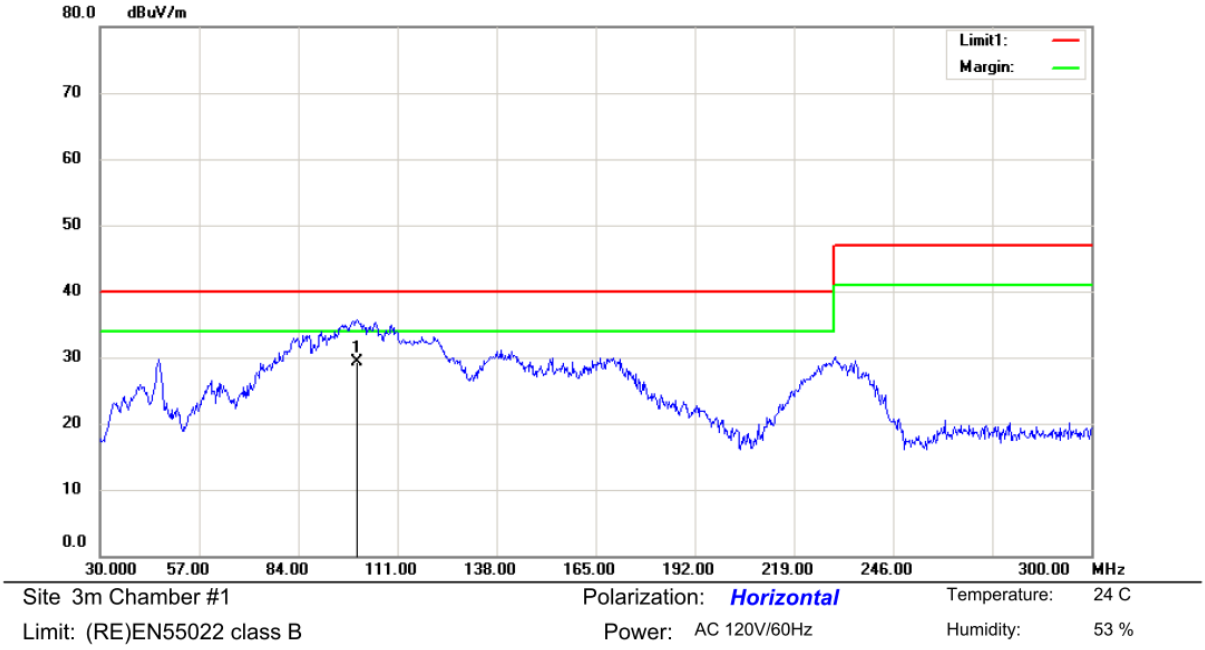


Figure 26 Radiated EMI -- 120VAC/60Hz Horizontal

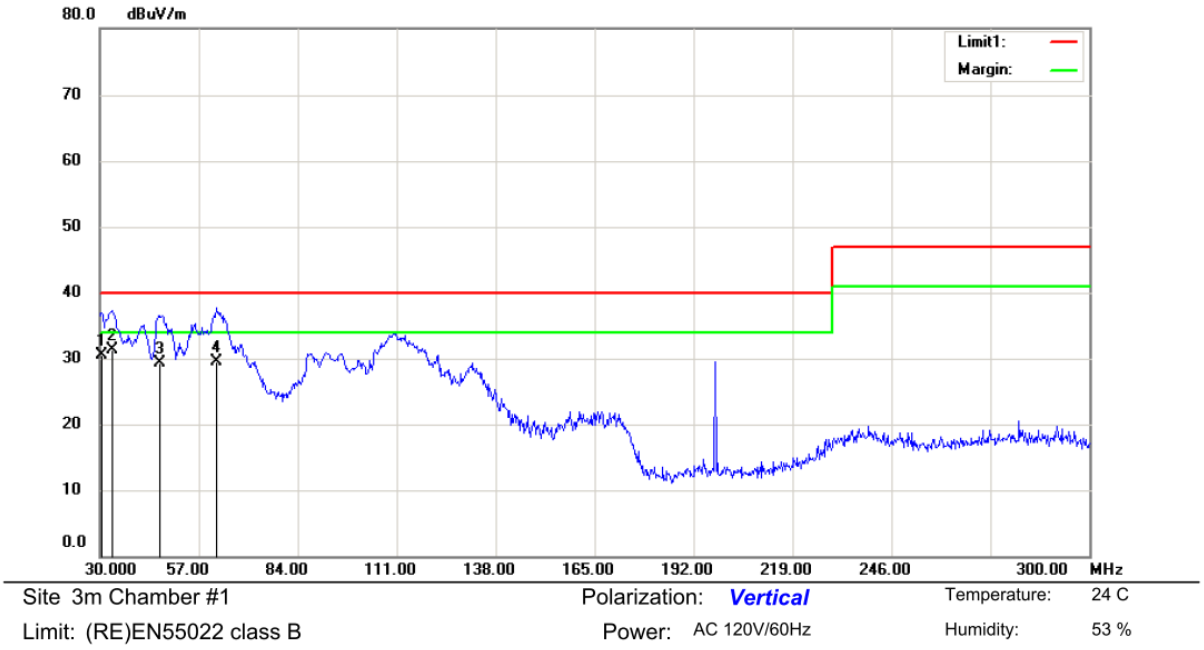


Figure 27 Radiated EMI -- 120VAC/60Hz Vertical

5 Surge, Flicker & Burst Test Results

5.1 Surge

深圳信测标准技术服务股份有限公司
深圳市南山区马家龙工业区69栋(518052)
www.emtek.com.cn Tel: +86-755-2695 4280 Fax: +86-755-2695 4282

EMTEK Access to the World

Surge Immunity Test Data

APPLICATION No:

APPLICANT: Finepower

DESCRIPTION OF SAMPLE(S)

Product:电源
Brand Name:
Model Number(s): 110W/54V LED DRIVER
Rating:

Prepared By: KY
Reviewed By:
Date: 2015-1-26
Test Result: ☒ Pass ☐ Fail

Test Specification: _____ Test Method: ☒ IEC61000-4-5 ☐ ANSI C62.41/45

Performance Criterion accepted by Test Specification: ☐A ☒B ☐C

Operation Mode: ☐ _____ ☒FULL LOAD

Conductor Under Test	Test Level	Count	Phase Angle	Surge Interval	Result *
☒ L-N ☒ L-PE ☒ N-PE	☐ ±0.5kV ☐ ±1.0kV ☒ ±2.0kV ☐ ±4.0kV ☐ ±6kV	☒ 5 ☐ ____	☐ 0° ☒ 90° ☐ 180° ☒ 270	☒ 60s ☐ _____ s	☐A ☒B ☐C ☐D
☐ L-N ☐ L-PE ☐ N-PE	☐ ±0.5kV ☐ ±1.0kV ☐ ±2.0kV ☐ ±4.0kV ☐ _____kV	☐ 5 ☐ ____	☐ 0° ☐ 90° ☐ 180° ☐ 270°	☐ 60s ☐ _____ s	☐A ☐B ☐C ☐D
☐ L-N ☐ L-PE ☐ N-PE	☐ ±0.5kV ☐ ±1.0kV ☐ ±2.0kV ☐ ±4.0kV ☐ _____kV	☐ 5 ☐ ____	☐ 0° ☐ 90° ☐ 180° ☐ 270	☐ 60s ☐ _____ s	☐A ☐B ☐C ☐D
☐ Tx-Rx ☐ Tx-PE ☐ Rx-PE	☐ ±0.5kV ☐ ±1.0kV ☐ ±2.0kV ☐ ±4.0kV ☐ _____kV	☐ 5 ☐ ____		☐ 60s ☐ _____ s	☐A ☐B ☐C ☐D
☐ Tx-Rx ☐ Tx-PE ☐ Rx-PE	☐ ±0.5kV ☐ ±1.0kV ☐ ±2.0kV ☐ ±4.0kV ☐ _____kV	☐ 5 ☐ ____		☐ 60s ☐ _____ s	☐A ☐B ☐C ☐D

* A: Normal performance within the specification limits
B: Temporary degradation or loss of function or performance which is self-recoverable
C: Temporary degradation or loss of function or performance which requires operator intervention or system reset
D: Degradation or loss of function which is not recoverable due to damage of equipment (components) or software, or loss of data

Overall Result Classification & Comments:

SHENZHEN EMTEK CO., LTD. TESTING

Climatic Condition:

Relative Humidity: 51 % Ambient Temperature: 21 ℃ Atmospheric Pressure: 101 kPa

Equipment used:

☒ In EMS Test Room

☒ Surge Controller	HAEFELY	Psurge 8000				
☒ Coupling Module	HAEFELY	PCD 130	☒	Impulse Module	HAEFELY	PIM 100
☒ Coupling Module	HAEFELY	PCD122	☒	Impulse Module	HAEFELY	PIM110
☒ Coupling Module	HAEFELY	PCD 126A	☒	Impulse Module	HAEFELY	PIM 120

编号: TR-4-E-005 Rev:A/1

5.2 Flicker

California Instruments
San Diego, California

1/21/2015
2:42 PM

Flicker Test Summary per EN/IEC61000-3-3 (Run time)

EUT:D1028
Test category: All parameters (European limits)
Test date: 2015/1/21
Test duration (min): 10
Comment: ON
Customer: FINEPOWER

Start time: 14:14:07
Data file name: F-000087.cts_data

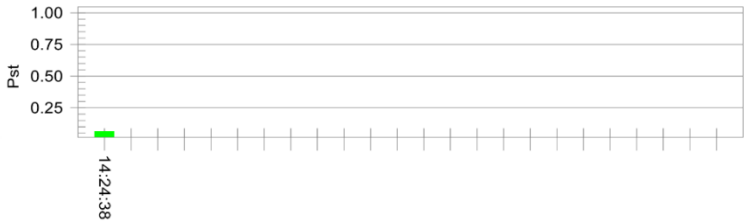
Tested by: KY
Test Margin: 100
End time: 14:24:39

Test Result: Pass

Status: Test Completed

Pst and limit line

European Limits



Plt and limit line

Parameter values recorded during the test:

Vrms at the end of test (Volt):	**229.75**			
Highest dt (%):	**0.00**	**Test limit (%):**	**3.30**	**Pass**
Tmax(mS) > dt:	**0**	**Test limit (mS):**	**500.0**	**Pass**
Highest dc (%):	**0.00**	**Test limit (%):**	**3.30**	**Pass**
Highest dmax (%):	**0.00**	**Test limit (%):**	**4.00**	**Pass**
Highest Pst (10 min. period):	**0.064**	**Test limit:**	**1.000**	**Pass**
Highest Plt (2 hr. period):	**0.028**	**Test limit:**	**0.650**	**Pass**

AMETEK Programmable Power CTS 4 V4.1.41

Page 1 of 1

Surge, Flicker & Burst Test Results

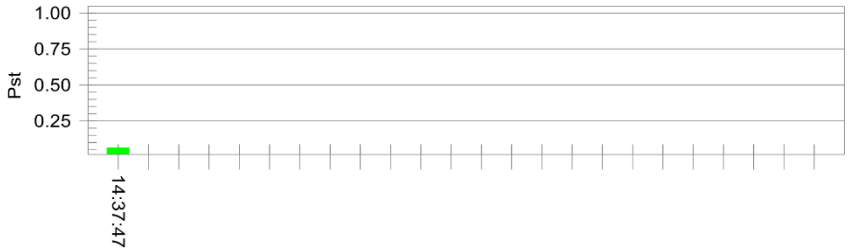
California Instruments 1/21/2015
San Diego, California 2:42 PM

Flicker Test Summary per EN/IEC61000-3-3 (Run time)

EUT: D1028 **Tested by: CSL**
Test category: All parameters (European limits) **Test Margin: 100**
Test date: 2015/1/21 **Start time: 14:27:17** **End time: 14:37:48**
Test duration (min): 10 **Data file name: F-000088.cts_data**
Comment: FULL LOAD
Customer: FINEPOWER

Test Result: Pass **Status: Test Completed**

Pst_i and limit line **European Limits**



Plt and limit line

Parameter values recorded during the test:

Vrms at the end of test (Volt):	**119.58**			
Highest dt (%):	**0.00**	**Test limit (%):**	**3.30**	**Pass**
Tmax(mS) > dt:	**0**	**Test limit (mS):**	**500.0**	**Pass**
Highest dc (%):	**0.00**	**Test limit (%):**	**3.30**	**Pass**
Highest dmax (%):	**0.00**	**Test limit (%):**	**4.00**	**Pass**
Highest Pst (10 min. period):	**0.064**	**Test limit:**	**1.000**	**Pass**
Highest Plt (2 hr. period):	**0.028**	**Test limit:**	**0.650**	**Pass**

AMETEK Programmable Power CTS 4 V4.1.41 Page 1 of 1

5.3 Burst

深圳信测标准技术服务股份有限公司
深圳市南山区马家龙工业区69栋(518052)
www.emtek.com.cn Tel: +86-755-2695 4280 Fax: +86-755-2695 4282

EMTEK
Access to the World

EFT/B Immunity Test Data

APPLICATION No: _____

APPLICANT: Finepower

DESCRIPTION OF SAMPLE(S)

Product: 电源
Brand Name:
Model Number(s):110W/54V LED DRIVER
Rating:

Prepared By: CL
Reviewed By:
Date: 2015-1-26
Test Result: ☒ Pass ☐ Fail

Test Specification: _____ Test Method: ☐ EN61000-4-4 ☒ IEC61000-4-4

Performance Criterion accepted by Test Specification: ☐ A ☒ B ☐ C

Operation Mode: ☐ Refer to EMC Test Requirements Form ☒ FULL LOAD

Conductor Under Test	Test Level	Duration	Result *
☒ AC ☐ DC ☐ Signal ☐ Control ☐ _____	☐ ±0.5kV ☒ ±1.0kV ☐ ±2.0kV ☐ ±4.0kV ☐ ±4.5 kV	☒ 120s ☐	☒ A ☐ B ☐ C ☐ D
☐ AC ☐ DC ☐ Signal ☐ Control ☐ _____	☐ ±0.5kV ☐ ±1.0kV ☐ ±2.0kV ☐ ±4.0kV ☐ _____ kV	☐ 120s ☐ _____s	☐ A ☐ B ☐ C ☐ D
☐ AC ☐ DC ☐ Signal ☐ Control ☐ _____	☐ ±0.5kV ☐ ±1.0kV ☐ ±2.0kV ☐ ±4.0kV ☐ _____ kV	☐ 120s ☐ _____s	☐ A ☐ B ☐ C ☐ D
☐ AC ☐ DC ☐ Signal ☐ Control ☐ _____	☐ ±0.5kV ☐ ±1.0kV ☐ ±2.0kV ☐ ±4.0kV ☐ _____ kV	☐ 120s ☐ _____s	☐ A ☐ B ☐ C ☐ D
☐ AC ☐ DC ☐ Signal ☐ Control ☐ _____	☐ ±0.5kV ☐ ±1.0kV ☐ ±2.0kV ☐ ±4.0kV ☐ _____ kV	☐ 120s ☐ _____s	☐ A ☐ B ☐ C ☐ D
☐ AC ☐ DC ☐ Signal ☐ Control ☐ _____	☐ ±0.5kV ☐ ±1.0kV ☐ ±2.0kV ☐ ±4.0kV ☐ _____ kV	☐ 120s ☐ _____s	☐ A ☐ B ☐ C ☐ D
☐ AC ☐ DC ☐ Signal ☐ Control ☐ _____	☐ ±0.5kV ☐ ±1.0kV ☐ ±2.0kV ☐ ±4.0kV ☐ _____ kV	☐ 120s ☐ _____s	☐ A ☐ B ☐ C ☐ D

* A: Normal performance within the specification limits
B: Temporary degradation or loss of function or performance which is self-recoverable
C: Temporary degradation or loss of function or performance which requires operator intervention or system reset
D: Degradation or loss of function which is not recoverable due to damage of equipment (components) or software, or loss of data

Overall result Classification & Comments:

SHENZHEN EMTEK CO., LTD. TESTING

Climatic Condition:

Relative Humidity: 55 % Ambient Temperature: 23 °C Atmospheric Pressure: 100 kPa

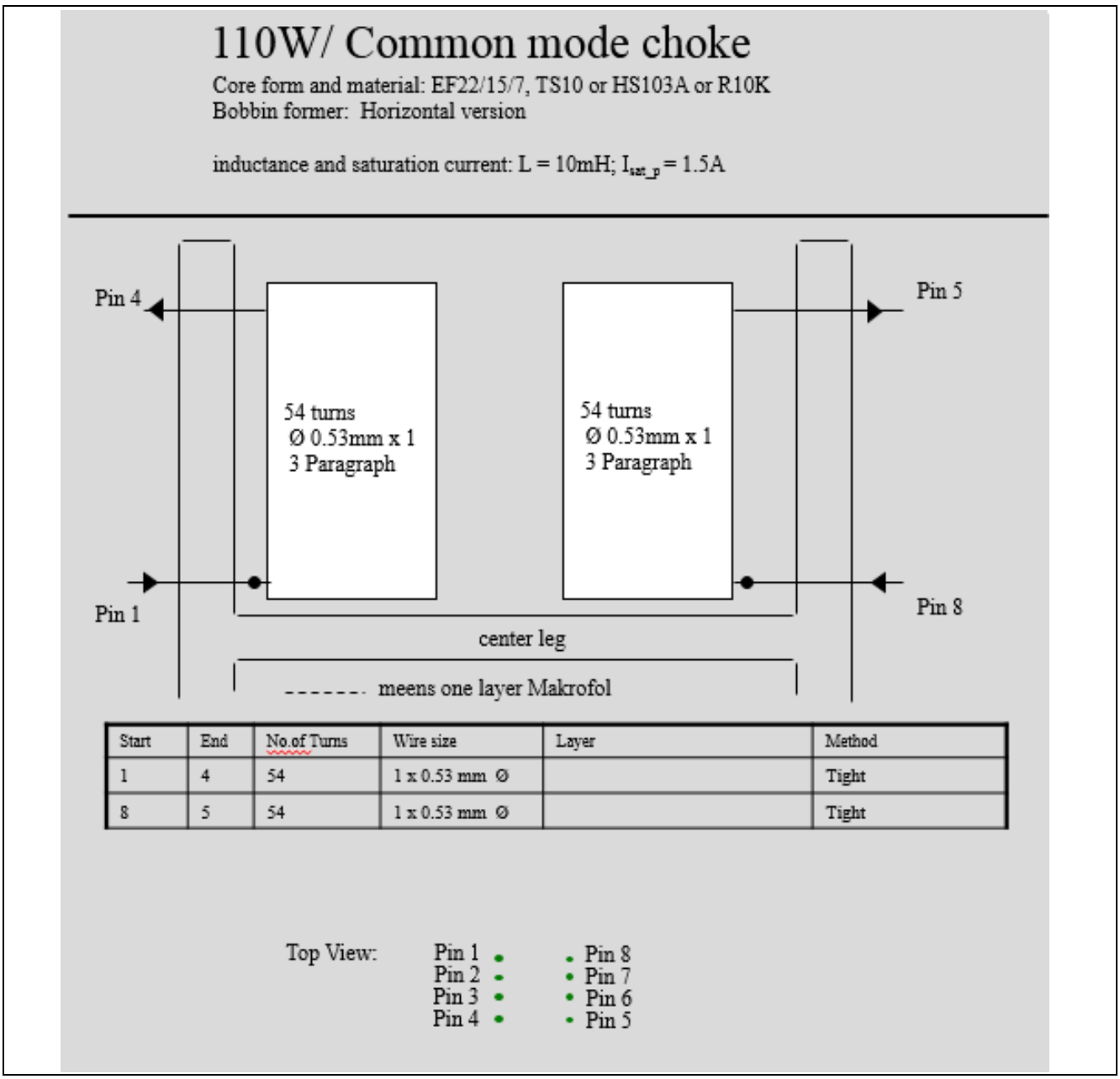
Equipment used:

☒ **In EMS Test Room**
☒ Burst Tester HAEFELY PEFT4010
☒ Coupling Clamp HAEFELY IP-4A

编号: TR-4-E-004 Rev:A/1

6 Power Transformer Specification

6.1 Common Mode Choke Spec L1



Start	End	No.of Turns	Wire size	Layer	Method
1	4	54	1 x 0.53 mm Ø		Tight
8	5	54	1 x 0.53 mm Ø		Tight

Figure 28 Common Mode Choke

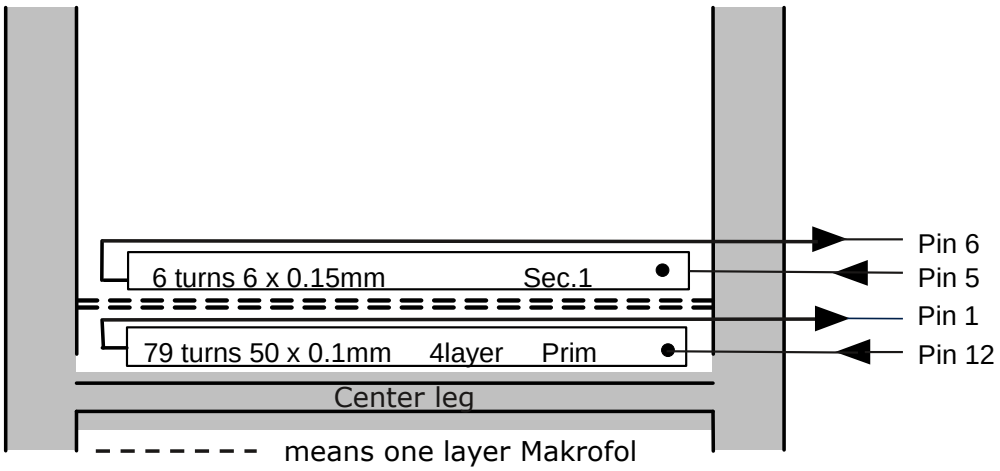
6.2 PFC Choke Spec T1

110W/ PFC Inductance

Core form and material:EV30,TPA44

Bobbin former: Horizontal version

Primary inductance and saturation current: L_P = 580µH / I_{SAT} = 6A



Start	End	No of Turns	Wire size	Layer	Method
12	1	79	50 x 0.1 mm	Primary	Tight
5	6	6	6 x 0.15 mm	Sec.1	Tight

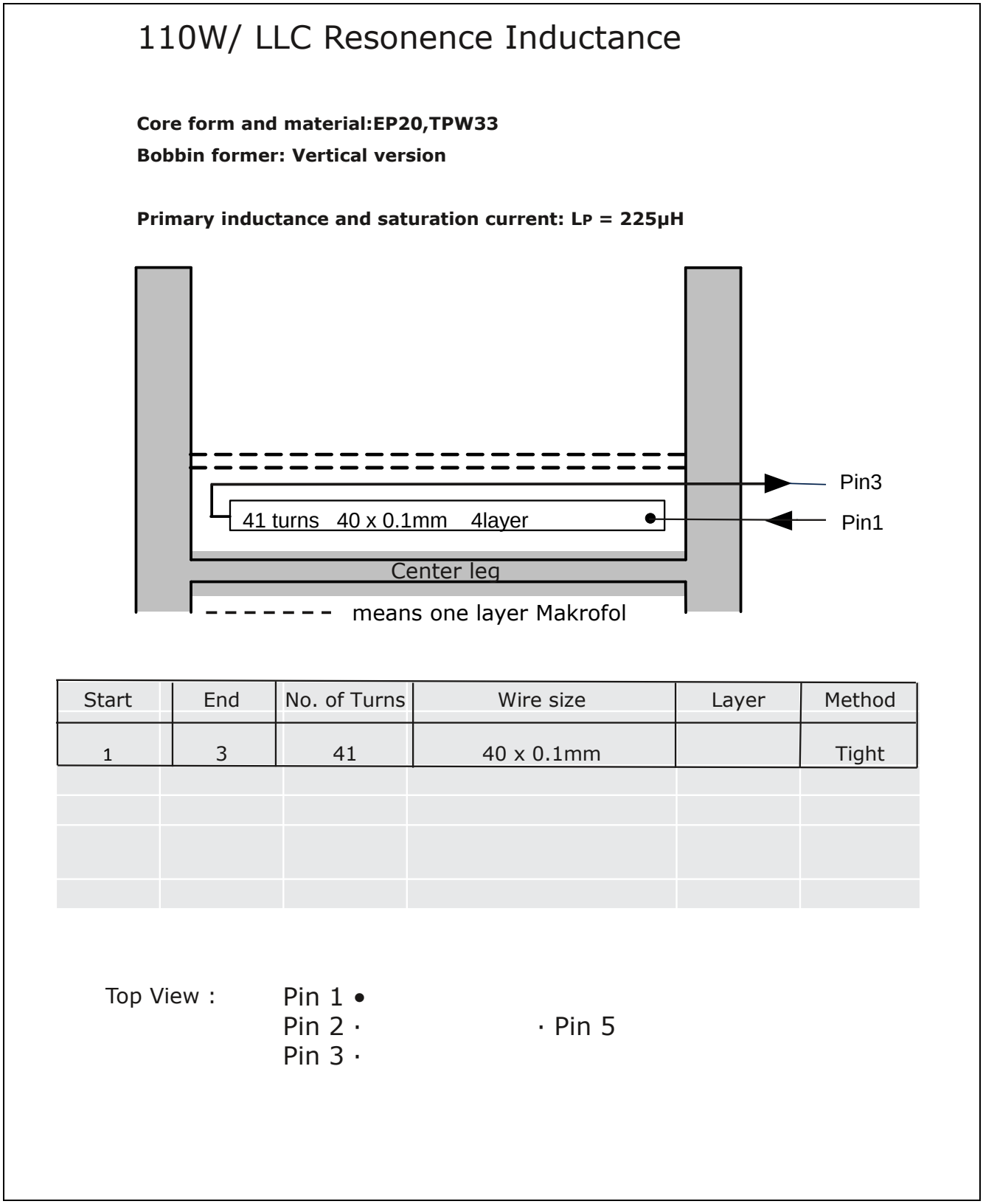
Top View:

Pin 1 • · Pin 12

Pin 5 ·
Pin 6

Figure 29 PFC Choke

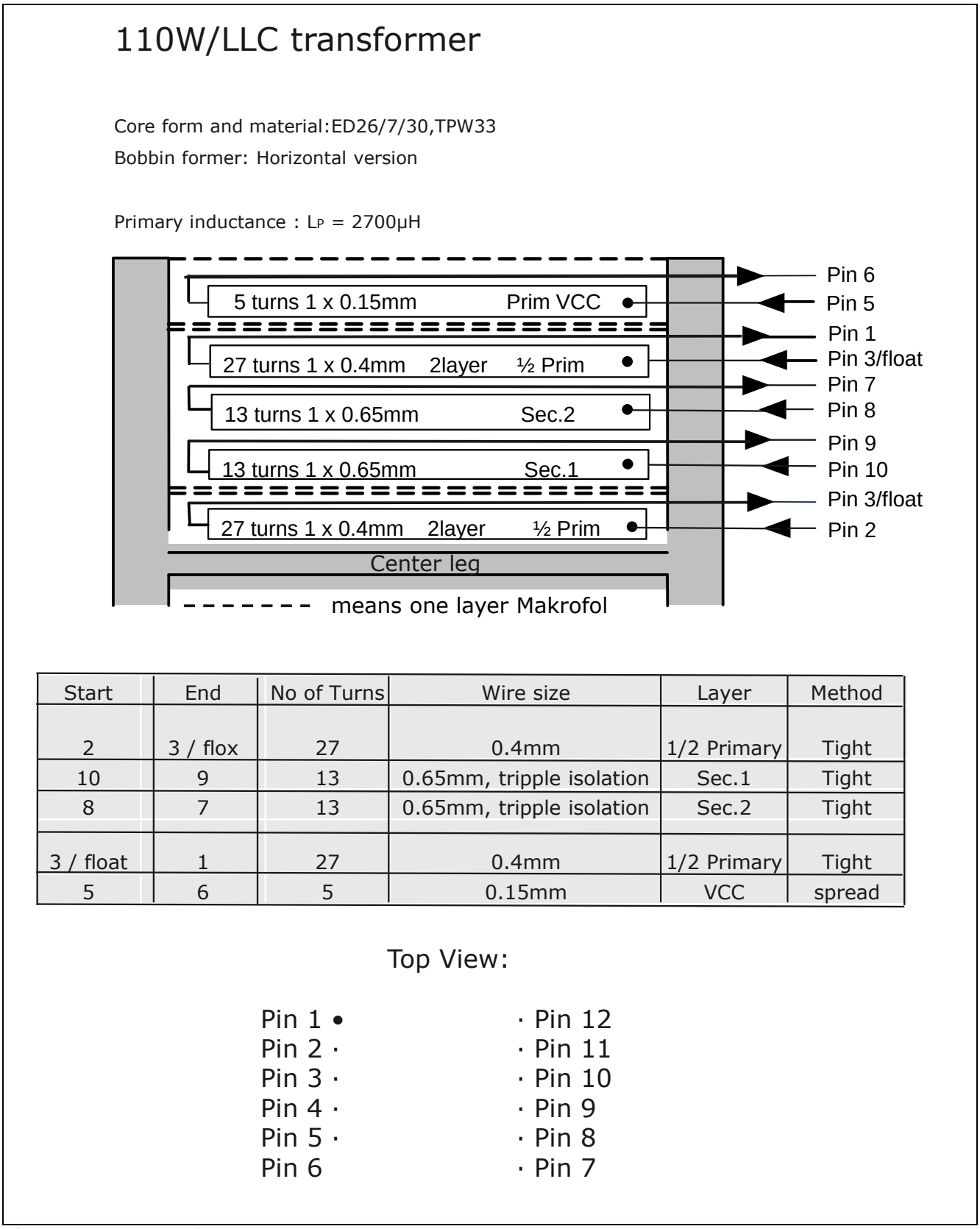
6.3 LLC Resonant Choke Spec L2



Start	End	No. of Turns	Wire size	Layer	Method
1	3	41	40 x 0.1mm		Tight

Figure 30 LLC Resonant Choke

6.4 LLC Transformer Spec T2



Start	End	No of Turns	Wire size	Layer	Method
2	3 / flox	27	0.4mm	1/2 Primary	Tight
10	9	13	0.65mm, tripple isolation	Sec.1	Tight
8	7	13	0.65mm, tripple isolation	Sec.2	Tight
3 / float	1	27	0.4mm	1/2 Primary	Tight
5	6	5	0.15mm	VCC	spread

Top View:

Pin 1 •	· Pin 12
Pin 2 ·	· Pin 11
Pin 3 ·	· Pin 10
Pin 4 ·	· Pin 9
Pin 5 ·	· Pin 8
Pin 6	· Pin 7

Figure 31 LLC Transformer

7 Board Layout

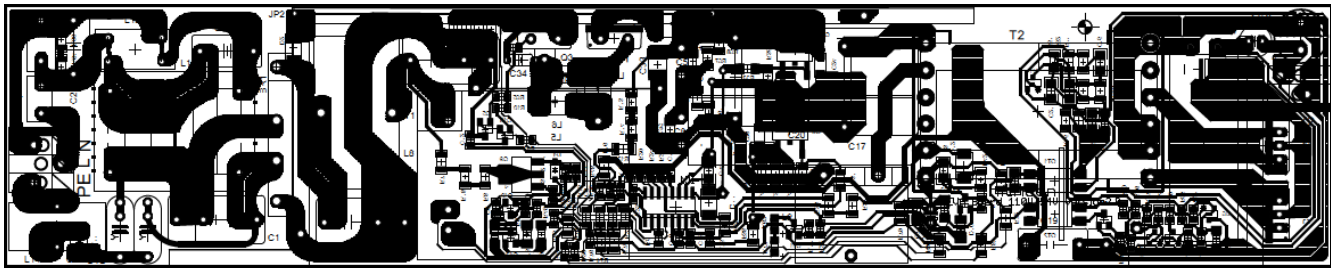


Figure 32 Layout of 110 W / 54 V Power Supply Demo Board (Bottom View)

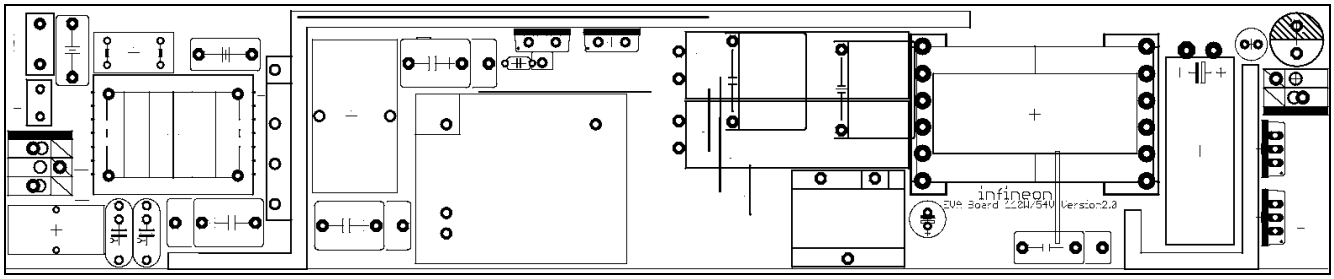


Figure 33 Assembly Print (Top View)

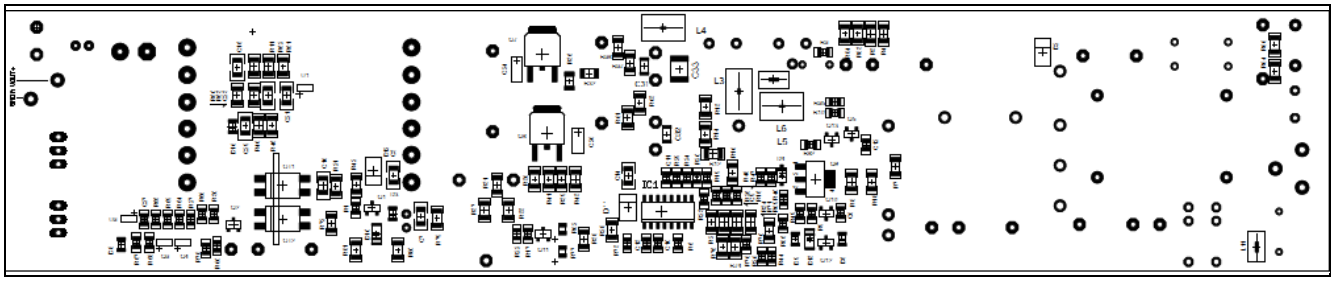


Figure 34 Assembly Print (Bottom View)

8 Bill of Material (BOM)

Designator	Part Value	Description	Packag/Footprint	Supplier	Order Number
BR1	LL15XB60	bridge, 15A/600V	GSIB-5S	SHINDENGEN	LL15XB60
C1	330nF/305V/X2	305V/X2 capacitor	FCAP-18-9-15/10	EPCOS	BS2922C3334M
C10	100nF/50V	ceramic capacitor	C0805		
C11	22nF/50V	ceramic capacitor	C0805		
C12	100nF/50V	ceramic capacitor	C0805		
C13	100pF/50V	ceramic capacitor	C0805		
C14	100nF/50V	ceramic capacitor	C1206		
C15	4n7/50V	ceramic capacitor	C1206		
C16	220nF/50V	ceramic capacitor	C1206		
C17	33nF/630V	film capacitor	FCAP-18-6-12-15-H	EPCOS	B32672L6333K
C18	100uF/35V	Aluminium Electrolyte	EUE2.5-7	RUBYCON	RUBYCON
C19	2n2/400V/Y2	400V/Y2 capacitor	FCAP-18-6-15/10		
C2	100nF/305V/X2	305V/X2 capacitor	FCAP-13-6-10	EPCOS	B32921C3104M
C20	150nF/520V	film capacitor	FCAP-18-6-12-15-H	EPCOS	B32672Z5154K
C21	220nF/50V	ceramic capacitor	C1206		
C22	330uF/100V	Aluminium Electrolyte	EUE5-B12,5-L35	RUBYCON	100ZLJ330M12.5X35
C23	100pF/50V	HV ceramic capacitor	C1206		
C24	100pF/630V	HV ceramic capacitor	C1206		
C25	100uF/100V	Aluminium Electrolyte	ECAP-10-5	RUBYCON	100ZLJ100M10X20
C26	100pF/630V	ceramic capacitor	C1206		
C27	1nF/50V	ceramic capacitor	C0805		
C28	100nF/305V/X2	305V/X2 capacitor	FCAP-18-9-15/10	EPCOS,	B32921C3104M
C29	100nF/50V	ceramic capacitor	C1206		
C3	2u2/50V	ceramic capacitor	C1206		
C30	470nF/630V	film capacitor	FCAP-18-6-15/10	EPCOS	B32922
C31	10nF/630V	HV ceramic capacitor	C1206		
C32	10nF/630V	HV ceramic capacitor	C1206		
C33	100nF/630V	HV ceramic capacitor	C1812		
C34	47pF/1kV	HV ceramic capacitor	C050-024x044		
C4	470nF/630V	film capacitor	FCAP-18-6-15/10	EPCOS	B32652A6224K
C5	150uF/250V	Aluminium Electrolyte	ECAP-12.5-5-H	NICHICON	UCY2E151MHD6
C6	100nF/50V	ceramic capacitor	C0805		
C7	2u2/50V	ceramic capacitor	C1206		
C8	150uF/250V	Aluminium Electrolyte	ECAP-12.5-5-H	NICHICON	UCY2E151MHD6
C9	2n2/50V	ceramic capacitor	C0805		
CY1	2n2/400V/Y2	400V/Y2 capacitor	FCAP-18-6-15/10		
CY2	2n2/400V/Y2	400V/Y2 capacitor	FCAP-18-6-15/10		
D1	8ETL06PBF	rectification diode	TO220-2	VISHAY	8ETL06PBF
D10	1N4148	small single switch diode	SOD-123_MINI-SM		
D11	MURS160	rectification diode	SMA	ON	ON
D12	SS210	rectification diode	SMA	VISHAY	VISHAY
D13	1N4148	small single switch diode	SOD-123_MINI-SM		
D14	V10150C	rectification diode	TO220	VISHAY	V10150C
D15	V10150C	rectification diode	TO220	VISHAY	V10150C
D16	BZT52C9V1	Zener diode	SOD-123_MINI-SM		
D2	S2JA	rectification diode	SMA	diodes	diodes
D3	BZT52C16	Zener diode	SOD-123_MINI-SM		

Bill of Material (BOM)

D4	BZT52C16	Zener diode	SOD-123_MINI-SM		
D5	BZT52C13	Zener diode	SOD-123_MINI-SM		
D8	BZT52C15	Zener diode	SOD-123_MINI-SM		
D9	BZT52C8V2	Zener diode	SOD-123_MINI-SM		
F1	3.15A/300V	fuse	FUSE8.5-4		
IC1	ICL5101	control IC	SOP16	INFINEON	ICL5101
L1	2x10mH CM choke	CM inductance	EMI_CHOKE_14,5X24, 5EF16LONG	ICT	NP2014-9132
L11	B core	bead	WE-CBF_1812	WÜRTH	742792515
L12	2X1mH/2A CM choke	CM choke	WE-CMB_XS	WÜRTH	744821201
L14	470uH/1A inductance	inductance	FERRITE_R16	WÜRTH	7447010
L2	IND,EF20	inductance	EF20	ICT	NP2014-9133
L3	B core	bead	WE_PBF_7427932	WÜRTH	7427932
L4	B core	bead	WE_PBF_7427932	WÜRTH	7427932
L5	B core	bead	WE_PBF_7427932	WÜRTH	7427932
L6	B core	bead	1812	WÜRTH	742792515
L7	4.7uH/3.7A inductance	inductance	5070	WÜRTH	7447462047
L8	860uH/3A inductance	inductance	WE_7447075	WÜRTH	7447075
OT1	VOL617A-3	optocoupler	DIL4-SMD	VISHAY	VOL617A-3
OT2	VOL617A-3	optocoupler	DIL4-SMD	VISHAY	VOL617A-3
Q1	PMMT491	NPN transister	SOT23		
Q10	KST2222	NPN transister	SOT23		
Q11	KST2222	NPN transister	SOT23		
Q12	KST2907	NPN transister	SOT23		
Q13	KST2222	NPN transister	SOT23		
Q2	KST5551MTF	NPN transister	SOT23		
Q3	IPP60R125C6	N MOSFET	TO220	INFINEON	IPP60R125C6
Q4	2N7002	N MOSFET	SOT23		
Q5	KST2907	PNP transistor	SOT23		
Q6	2N7002	N MOSFET	SOT23		
Q7	IPD60R450E6	N MOSFET	TO252	INFINEON	IPD60R450E6
Q8	IPD60R450E6	N MOSFET	TO252	INFINEON	IPD60R450E6
Q9	BSP135	depletion MOSFET	SOT223	INFINEON	BSP135
R1	10k	film resistor	R0805		
R10	4R99	film resistor	R0805		
R11	2K	film resistor	R1206		
R12	562K	film resistor	R1206		
R13	2M	film resistor	R1206		
R14	2M	film resistor	R1206		
R15	25K5	film resistor	R0805		
R16	0R	film resistor	R1206		
R17	10k	film resistor	R0805		
R18	2K21	film resistor	R1206		
R19	12k1	film resistor	R0805		
R2	51k1	film resistor	R1206		
R20	n.c.	film resistor	R0805		
R21	0R	film resistor	R1206		
R22	133k	film resistor	R0805		
R23	9k1	film resistor	R0805		
R24	0R0	film resistor	R0805		
R25	47k5	film resistor	R0805		
R26	0R	film resistor	R0805		

Bill of Material (BOM)

R27	4M02	film resistor	R0805		
R28	10R	film resistor	R1206		
R29	0R	film resistor	R0805		
R3	0R68	film resistor	R1206		
R30	33K	film resistor	R0805		
R31	22R	film resistor	R1206		
R32	22R	film resistor	R1206		
R33	n.c.	film resistor	R1206		
R34	0R0	film resistor	R1206		
R35	10k	film resistor	R1206		
R36	10k	film resistor	R1206		
R37	n.c.	film resistor	R1206		
R38	1K	film resistor	R1206		
R39	1R5	film resistor	R1206		
R4	0R68	film resistor	R1206		
R40	35R	film resistor	R0805		
R41	1R5	film resistor	R1206		
R42	2R	film resistor	R1206		
R43	2R0	film resistor	R1206		
R44	10K	film resistor	R0805		
R45	30K	film resistor	R1206		
R46	680R	film resistor	R1206		
R47	10K	film resistor	R0805		
R48	10K	film resistor	R0805		
R49	100R	film resistor	R0805		
R5	0R0	film resistor	R0805		
R50	7K5	film resistor	R1206		
R51	20K	film resistor	R1206		
R52	127K	film resistor	R1206		
R53	34K	film resistor	R1206		
R54	221K	film resistor	R0805		
R55	51K	film resistor	R0805		
R56	464K	film resistor	R0805		
R57	200K	film resistor	R0805		
R58	182K	film resistor	R0805		
R59	830K	film resistor	R0805		
R6	10k	film resistor	R0805		
R60	150K	film resistor	R0805		
R61	1M	film resistor	R1206		
R62	680R	PTC	R0805	EPCOS	B59701A0100A062
R63	1M	film resistor	R1206		
R64	n.c.	film resistor	R1206		
R65	15R	film resistor	R0805		
R66	n.c.	film resistor	R1206		
R67	1M	film resistor	R1206		
R68	1M	film resistor	R1206		
R69	0R	film resistor	R1206		
R7	2k21	film resistor	R1206		
R70	0R	film resistor	R1206		
R71	0R	film resistor	R1206		
R72	0R	film resistor	R1206		
R73	0R	film resistor	R0805		

Bill of Material (BOM)

R74	0R	film resistor	R1206		
R75	0R	film resistor	R1206		
R76	0R	film resistor	R0805		
R77	680R	PTC	R0805	EPCOS	B59701A0100A062
R78	255K	film resistor	R0805		
R79	0R	film resistor	R1206		
R8	2k21	film resistor	R1206		
R80	0R	film resistor	R1206		
R81	0R	film resistor	R1206		
R82	22R	film resistor	R0805		
R83	0R68	film resistor	R1206		
R84	0R5	film resistor	R1206		
R85	20K	film resistor	R0805		
R9	100K	film resistor	R0805		
T1	EVD30	PFC inductance	EVD30	ICT	NP2014-9135
T2	transformer	llc transformer	ED26/7/30-12PIN	ICT	NP2014-9134
U1	AZ431	V-regulator	SOT-23		
U6	AZ431	V-regulator	SOT-23		
VR1	S10K350E2K1	varistor	VR-8*4*5P	EPCOS	S10K350E2K1
X1	3pin connector	connector	WAGO3P	WÜRTH	691412120003B
X2	2pin connector	connector	WAGO2P	WÜRTH	691412120002B
	heatsink-second	heatsink			
	heatsink-prim.	heatsink			

9 References

[1] ICL5101 Data Sheet

Revision History

Major changes since the last revision

Date	Version	Changed by	Change Description
2015-02-03	1.1	KLING	Published & initial
2015-02-11	2.0	KLING	EMI Performance Conductive and Radiated / CE Certificated
2015-02-11	2.0	KLING	Section 1: Board Photo
2015-02-13	2.0	KLING	Section 2: Board Dimension Adjustment
2015-02-13	2.0	KLING	Section 3: Schematic
2015-02-13	2.0	KLING	Section 4: Complete Update
2015-02-13	2.0	KLING	Section 4.4: EMI Test (NEW)
2015-02-13	2.0	KLING	Section 5: Surge, Flicker and Burst (NEW)
2015-02-13	2.0	KLING	Section 7: Board Layout (Update)
2015-02-13	2.0	KLING	Section 8: Bill of Material BOM (Update)
2015-02-19	2.0	KLING	Improved Resolution of Figure: 2 / 29 / 30 / 31
2015-02-19	2.0	KLING	Section 4.1.2: Start-Up Time, Update of Figure 4 until Figure 9
2015-02-24	2.1	KLING	Schematic Update Figure: 2
2015-03-02	2.1	KLING	LLC Transformer Figure: 28 / Resolution
2015-03-04	2.1	KLING	Resonant Choke Figure: 27 / Resolution
2015-02-05	2.1	KLING	Schematic Update Figure: 2 / BOM Update
2015-03-04	2.1	KLING	PFC Choke Figure: 26 / Resolution
2015-04-13	2.1	KLING	Update BOM / including Supplier and Part Number
2015-06-19	2.1	KLING	Typo Correction
2015-07-24	2.1	KLING	Figure 11 update / Figure 12 new
2015-07-27	2.1	KLING	Add THD description for stable and vary load condition
2015-07-27	2.1	KLING	Add Surge protection feature
2015-09-19	2.2	KLING	BOM & Schematic correction: L8: Value / C30 + D1 Partnr.
2015-09-19	2.2	KLING	Overall correction

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